Click here to ask about the production status of specific part numbers.

#### MAX77642/MAX77643

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life

#### **General Description**

The MAX77642/MAX77643 provide power supply solutions for low-power applications where size and efficiency are critical. The IC features a SIMO buck-boost regulator that provides three independently programmable power rails from a single inductor to minimize total solution size. A 150mA LDO provides ripple rejection for audio and other noise-sensitive applications. The LDO can also be configured as load switches to manage power consumption by disconnecting external blocks when not required.

The MAX77642's SIMO and LDO output voltages are individually programmable through resistors. A peak current limit input is used to set both the inductor's peak current limits of the device with a single resistor. Individual enable pins combined with the flexible resistor programmability allows the device to be tailored for many applications.

This MAX77643's SIMO and LDO output voltages are individually programmable through I<sup>2</sup>C and in addition, includes two GPIOs with alternate modes for scalability. A bidirectional I<sup>2</sup>C serial interface allows for configuring and checking the status of the devices. An internal on/off controller provides a controlled startup sequence for the regulators and provides supervisory functionality while they are on. Numerous factory programmable options allow the device to be tailored for many applications, enabling faster time to market.

### **Applications**

- Next Generation Hearables
- Fitness, Health, and Activity Monitors
- Safety and Security Monitors
- Portable Consumer Devices

#### **Benefits and Features**

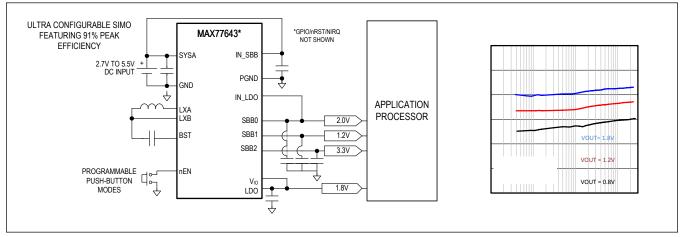
- Highly Integrated
  - 3x Output, Single-Inductor Multiple-Output (SIMO) Buck-Boost Regulator
    - Supports Wide Output Voltage Range from 0.5V to 5.5V for all SIMO Channels
  - 1x 150mA LDO
  - 100mA in LSW mode
  - 2x GPIOs (MAX77643)
  - Watchdog Timer (MAX77643)
- Ultra Low-Power SIMO
  - 5µA Operating Current (3x SIMO Channels + 1x LDOs)
  - 1µA Operating Current per SIMO Channel
  - 0.3µA Shutdown Current
  - 93% Peak Efficiency in Boost-Only Mode
  - 91% Peak Efficiency in Buck-Only Mode
  - Less Than 20mVpp Output Ripple at V<sub>OUT</sub> = 1.8V
  - Automatic Low-Power Mode to Normal-Power Mode Transition
- Flexible and Configurable
  - Ultra-Configurable Resistor Programmable Output Voltages (MAX77642)
  - I<sup>2</sup>C-Programmable Output Voltages (MAX77643)
- Small Size
  - 4.24mm<sup>2</sup> Wafer-Level Package (WLP)
  - 25-Bump, 0.4mm Pitch, 5 x 5 Array

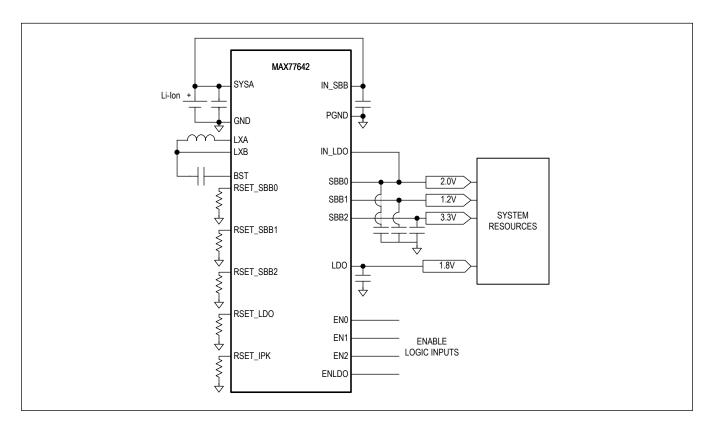
Ordering Information appears at end of data sheet.



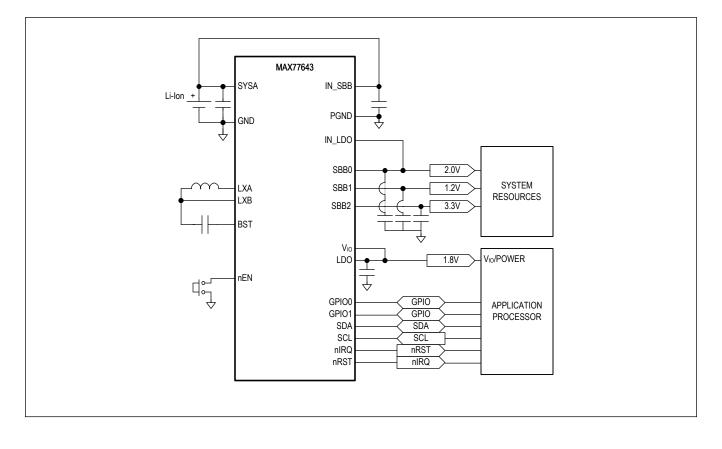
### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### Simplified Block Diagram





### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications



Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

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### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Absolute Maximum Ratings**

nEN, nIRQ, nRST, RSET_SBB0, RSET_SBB1, RSET_SBB2,	BST to IN0.3V to +6.0V
RSET_LDO, RSET_IPK, ENO, EN1, EN3 to GND-0.3V to V <sub>SYSA</sub>	BST to LXB0.3V to +6.0V
+ 0.3V	SBB0, SBB1, SBB2 Short-Circuit DurationContinuous
SCL, SDA to GND0.3V to V <sub>IO</sub> + 0.3V	PGND to GND0.3V to +0.3V
V <sub>SYSA</sub> to GND0.3V to +6.0V	Operating Temperature Range40°C to +125°C
nIRQ, nRST, SDA, GPIO Continuous Current	Junction Temperature+150°C
IN_SBB Continuous Current (Note 1)1.2A <sub>RMS</sub>	Storage Temperature Range65°C to +150°C
IN_SBB to GND0.3V to +6.0V	Soldering Temperature (reflow)+260°C
LDO to GND0.3V to V <sub>IN LDO</sub> + 0.3V	Continuous Power Dissipation (Multilayer Board, T <sub>A</sub> = +70°C,
IN_LDO to GND	derate 20.4mW/°C above +70°C)1632mW
LXA Continuous Current (Note 2)1.2ARMS	GPIO0/1 to GND0.3V to V <sub>IO</sub> + 0.3V
LXB Continuous Current (Note 2) 1.2A <sub>RMS</sub>	SYSA to GND0.3V to +6.0V
SBB0, SBB1, SBB2 to PGND0.3V to +6.0V	V <sub>IO</sub> 0.3V to SYSA + 0.3V

Note 1: Do not repeatedly hot-plug a source to the IN terminal at a rate greater than 10Hz. Hot plugging low impedance sources results in an ~8A momentary (~2µs) current spike.

Note 2: Do not externally bias LXA or LXB. LXA has internal clamping diodes to PGND and IN. LXB has an internal low-side clamping diode to PGND and an internal high-side clamping diode that dynamically connects to a selected SIMO output. It is normal for these diodes to briefly conduct during switching events. When the SIMO regulator is disabled, the LXB to PGND absolute maximum voltage is -0.3V to V<sub>SBB0</sub> + 0.3V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **Package Information**

#### WLP

Package Code	N252B2+1
Outline Number	<u>21-100480</u>
Land Pattern Number	Refer to Application Note 1891
Thermal Resistance, Four-Layer Board:	
Junction to Ambient ( $\theta_{JA}$ )	49°C/W (2s2p board)

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Electrical Characteristics**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V, V_{IO} = 1.8V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range ( $T_A = -40^{\circ}C$  to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Operating Voltage Range	V <sub>IN</sub>			2.7		5.5	V
Shutdown Supply Current	I <sub>SHDN</sub>	Current measured into IN_SBB and IN_LDO, all resources are off (LDO, SBB0, SBB1, SBB2). $T_A =$ +25°C	Main bias is off. This is the standby state		0.3	1	μΑ
Main Bias Quiescent Current	ΙQ	Main bias is in normal-power mode (CNFG_GLBL.SBIA_LPM = 0)			28		μA
Quiescent Supply Current	ΙQ	Current measured into IN_SBB and IN_LDO. LDO0, SBB0, SBB1, SBB2 are enabled with no load watchdog timer disabled	Main bias is in low- power mode (CNFG_GLBL.SBI A_LPM = 1)		4.5	11	μA

#### **Electrical Characteristics—Global Resources**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range  $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C)$  are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS					
GENERAL CHARACTER	GENERAL CHARACTERISTICS										
Main Bias Enable Time	<sup>t</sup> SBIAS_EN			0.5		ms					
VOLTAGE MONITORS /	VOLTAGE MONITORS / POWER-ON RESET (POR)										
POR Threshold	V <sub>POR</sub>	V <sub>SYSA</sub> falling		1.55		V					
POR Threshold Hysteresis				150		mV					
VOLTAGE MONITORS /	UNDERVOLTAG	E LOCKOUT (UVLO)	•								
UVLO Threshold	V <sub>SYSAUVLO</sub>	V <sub>SYSA</sub> falling, UVLO_F[3:0] = 0xA (Note 3)	2.45	2.6	2.73	V					
UVLO Threshold Hysteresis	V <sub>SYSAUVLO_H</sub> YS	TUVH[3:0] = 0x5 (Note 3)		300		mV					
VOLTAGE MONITORS /	OVERVOLTAGE	LOCKOUT (OVLO)									
OVLO Threshold	V <sub>SYSAOVLO</sub>	V <sub>SYSA</sub> rising	5.70	5.85	6.00	V					
THERMAL MONITORS											
Overtemperature Lockout Threshold	T <sub>OTLO</sub>	T <sub>J</sub> rising		145		°C					
Thermal Alarm Temperature 1	T <sub>JAL1</sub>	T <sub>J</sub> rising		80		°C					

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Electrical Characteristics—Global Resources (continued)**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range  $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C)$  are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONE	DITIONS	MIN	TYP	MAX	UNITS
Thermal Alarm Temperature 2	T <sub>JAL2</sub>	T <sub>J</sub> rising			100		°C
Thermal Alarm Temperature Hysteresis					15		°C
ENABLE INPUT (nEN, E	Nx)						
nEN Input Leakage Current	l <sub>nEN_LKG</sub>	V <sub>nEN</sub> = V <sub>SYSA</sub> = 5.5V	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	-1	±0.001 ±0.01	+1	μA
nEN Input Falling Threshold	VTH_nEN_F	nEN Falling		0.4			V
nEN Input Rising Threshold	V <sub>TH_nEN_R</sub>	nEN rising				1.4	V
EN Input Threshold, High	VIH	Voltage threshold, r	ising	1.4			V
EN Input Threshold, Low	V <sub>IL</sub>	Voltage threshold, fa			0.4	V	
Debounce Time	toolo ou	CNFG_GLBL0.DBE	N_nEN = 0		500		μs
	<sup>t</sup> DBNC_nEN	CNFG_GLBL0.DBE	CNFG_GLBL0.DBEN_nEN = 1		30		ms
Manual Reset Time	t	CNFG_GLBL0.T_MRST = 1 3		3	4	5	6
Manual Reset Time	t <sub>MRST</sub>	RST CNFG_GLBL0.T_MRST = 0 7		8	10.5	S	
nEN Internal Pullup	D	CNFG_GLBL0.PU_ DIS = 0 200		- kΩ			
	R <sub>nEN-PU</sub>	Pullup to V <sub>SYSA</sub>	CNFG_GLBL0.PU_ DIS = 1		10000		K12
EN Internal Pulldown	R <sub>EN-PD</sub>	Pulldown to GND			50		nA
OPEN-DRAIN INTERRUP	PT OUTPUT (nlF	RQ)					
Output Voltage Low	V <sub>OL</sub>	I <sub>SINK</sub> = 2mA				0.4	V
Output Falling Edge Time	<sup>t</sup> f_nIRQ	C <sub>IRQ</sub> = 25pF			2		ns
		V <sub>SYSA</sub> = V <sub>IO</sub> =	T <sub>A</sub> = +25°C	-1	±0.001	+1	
Leakage Current	l <sub>nIRQ_LKG</sub>	5.5V nIRQ is high impedance (no interrupts) V <sub>nIRQ</sub> = 0V and 5.5V	T <sub>A</sub> = +85°C		±0.01		μA
OPEN-DRAIN RESET OU	JTPUT (nRST)						
Output Voltage Low	V <sub>OL</sub>	I <sub>SINK</sub> = 2mA				0.4	V
Output Falling Edge Time	<sup>t</sup> f_nRST	C <sub>RST</sub> = 25pF			2		ns
nRST Deassert Delay Time	<sup>t</sup> RSTODD	See Figure 11 for m	ore information		5.12		ms

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Electrical Characteristics—Global Resources (continued)**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range  $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C)$  are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
nRST Assert Delay Time	t <sub>RSTOAD</sub>				10.24		ms
Leakage Current	InRST_LKG	$V_{SYSA} = V_{IO} =$ 5.5V nRST is high impedance (no reset) $V_{nRST} = 0V$ and 5.5V	T <sub>A</sub> = +25°C	-1	±0.001	+1	μΑ
		$V_{SYS} = V_{IO} = 5.5V$ nRST is high impedance (no reset) $V_{nRST} = 0V$ and 5.5V	T <sub>A</sub> = +85°C		±0.01		h, r
GENERAL PURPOSE IN	PUT/OUTPUT (C	SPIO)		•			
GPIO Supply Voltage Range					V <sub>IO</sub>		V
Input Voltage Low	VIL	V <sub>IO</sub> = 1.8V				0.3 x V <sub>IO</sub>	V
Input Voltage High	VIH	V <sub>IO</sub> = 1.8V		0.7 x V <sub>IO</sub>			V
Input Leakage Current	Igpi_lkg	CNFG_GPIOx.DIR = 1 $V_{IO}$ = 5.5V $V_{GPIO}$ = 0V and 5.5V	$T_{A} = +25^{\circ}C$ $T_{A} = +85^{\circ}C$	-1	±0.001 ±0.01	+1	μA
Output Voltage Low	V <sub>OL</sub>	I <sub>SINK</sub> = 2mA	1			0.4	V
Output Voltage High	V <sub>OH</sub>	I <sub>SOURCE</sub> = 1mA		0.8 x V <sub>IO</sub>			V
Input Debounce Time	<sup>t</sup> DBNC_GPI	CNFG_GPIOx.DBE	N_GPI = 1		30		ms
Output Falling Edge Time	<sup>t</sup> f_GPIO	C <sub>GPIO</sub> = 25pF			3		ns
Output Rising Edge Time	t <sub>r_GPIO</sub>	C <sub>GPIO</sub> = 25pF			3		ns
FLEXIBLE POWER SEQU	JENCER						
FPS Startup Delay	tFPS_DLY				1.43		ms
Power-Up Event Periods	t <sub>EN</sub>	See Figure 10			1.28		ms
Power-Down Event Periods	t <sub>DIS</sub>	See Figure 10			2.56		ms
RSET (MAX77642)							
Select Resistor Detection Time	<sup>t</sup> RSET	Total time to detect all five resistors	V <sub>IN_SBB</sub> = 2.7V, C <sub>RSET</sub> < 2pF		3		ms
Required Select Resistor Accuracy	R <sub>SEL_TOL</sub>	Use the nearest ±1% R <sub>SEL</sub> Selection Tabl		-1		+1	%

Note 3: Programmed at Maxim's factory.

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Electrical Characteristics—SIMO Buck-Boost**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V, C_{SBBx} = 10\mu$ F, L = 1.5µH, limits are 100% production tested at T<sub>A</sub> = +25°C, limits over the operating temperature range (T<sub>A</sub> = -40°C to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
GENERAL CHARACTER	ISTICS / OUTPL	JT VOLTAGE RANGE	(SBB0)				
Programmable Output Voltage Range				0.5		5.5	V
Output DAC Bits					8		bits
Output DAC LSB Size		0.5V to 5.5V			25		mV
GENERAL CHARACTER	ISTICS / OUTPL	JT VOLTAGE RANGE	(SBB1)				
Programmable Output Voltage Range				0.5		5.5	V
Output DAC Bits					8		bits
Output DAC LSB Size		0.5V to 5.5V			25		mV
GENERAL CHARACTER	ISTICS / OUTPL	JT VOLTAGE RANGE	(SBB2)				
Programmable Output Voltage Range				0.5		5.5	V
Output DAC Bits					8		bits
Output DAC LSB Size		0.5V to 5.5V			25		mV
OUTPUT VOLTAGE ACC	URACY	-		•			•
Output Voltage Accuracy		V <sub>SBBx</sub> falling, threshold where LXA switches high. Specified as a percentage of	$T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +125^{\circ}C	-2.0		+2.0	%
OUT Over-Regulation Threshold	V <sub>OV</sub>	target output voltage. $T_A = +25^{\circ}C$			1.7	3.3	%
TIMING CHARACTERIST	ICS						
Enable Delay		Delay time from the first enable signal to switch in order to set	when it begins to		10		μs
Soft-Start Slew Rate	dV/dt <sub>SS</sub>	I <sub>PK</sub> = 1A, C <sub>OUT</sub> = 10	)μF		5.0		mV/µs
POWER STAGE CHARA	CTERISTICS						·
		SBB0, SBB1,	T <sub>A</sub> = +25°C	-1.0	±0.1	+1.0	
LXA Leakage Current		SBB2 are disabled, $V_{IN\_SBB} = 5.5V$ , $V_{LXA} = 0V$ , or 5.5V	T <sub>A</sub> = +85°C		±1.0		μA
		SBB0, SBB1,	T <sub>A</sub> = +25°C	-1.0	±0.1	+1.0	
LXB Leakage Current		SBB2 are disabled, $V_{IN\_SBB} = 5.5V$ , $V_{LXA} = 0V \text{ or } 5.5V$ , all $V_{SBBx} = 5.5V$	T <sub>A</sub> = +85°C		±1.0		μΑ
	V <sub>IN SBB</sub> = 5.5V, T <sub>A</sub>	T <sub>A</sub> = +25°C		+0.01	+1.0		
BST Leakage Current		V <sub>LXB</sub> = 5.5V, V <sub>BST</sub> = 11V	T <sub>A</sub> = +85°C		+0.1		μA

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Electrical Characteristics—SIMO Buck-Boost (continued)**

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V, C_{SBBx} = 10\mu$ F, L = 1.5µH, limits are 100% production tested at T<sub>A</sub> = +25°C, limits over the operating temperature range (T<sub>A</sub> = -40°C to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
		SBB0, SBB1,	T <sub>A</sub> = +25°C		+0.1	+1.0	
Disabled Output Leakage Current		SBB2 are disabled, active-discharge disabled (CNFG_SBBx_B.A DE_SBBx = 0), $V_{SBBx} = 5.5V$ , $V_{LXB} = 0V$ , $V_{SYSA}$ = $V_{IN}$ _SBB = $V_{BST}$ = 5.5V	T <sub>A</sub> = +85°C		+0.2		μA
Active Discharge Resistance	R <sub>AD_SBBx</sub>	discharge enabled	SBB0, SBB1, SBB2 are disabled, active discharge enabled (CNFG SBBx B.ADE SBBx = 1)		120	180	Ω
CONTROL SCHEME							
		CNFG_SBBx_B.IP_S	SBBx[1:0] = 0b11	-18%	0.335	+18%	
Peak Current Limit	I <sub>P_SBB</sub> (Note	CNFG_SBBx_B.IP_S	SBBx[1:0] = 0b10	-14% 0.500	0.500	+14%	A
	4)	CNFG_SBBx_B.IP_S	SBBx[1:0] = 0b01	-8%	0.750	+8%	
		CNFG_SBBx_B.IP_S	SBBx[1:0] = 0b00	-7%	1.000	+7%	

Note 4: Typical values align with bench observations using the stated conditions with an inductor. Minimum and maximum values are tested in production with DC currents without an inductor. See the *Typical Operating Characteristics* SIMO switching waveforms to gain more insight on this specification.

#### Electrical Characteristics—Low Dropout Linear Regulator (LDO)/Load Switch (LSW)

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range  $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C)$  are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LDO	·					
Innut Voltago Dango	Maxim	LDO mode	1.71		5.5	v
Input Voltage Range	VIN_LDO	Switch mode	1.2		5.5	
Quiescent Supply		I <sub>OUT_LDOx</sub> = 0		1.4	2.4	
Current	IIN_LDO	I <sub>OUT_LDOx</sub> = 0, switch mode		0.5	1.2	μA
Quiescent Supply Current In Dropout	IIN_DRP_LDO	$I_{OUT\_LDOx} = 0, V_{IN\_LDOx} = 2.9V, V_{LDOx} = 3V$		2.1	4.6	μA
Maximum Output		V <sub>IN_LDOx</sub> > 1.8V	150			
Current	IOUT_LDO	V <sub>IN_LDOx</sub> = 1.8V or lower	100			mA
Output Voltage (MAX77642)	V <sub>OUT_LDO</sub>		0.5		3.975	V
Output Voltage (MAX77643)	V <sub>OUT_LDO</sub>		0.5		5.0	V
Output Accuracy		$V_{IN\_LDOx} = (V_{OUT\_LDOx} + 0.5V)$ or higher, $I_{OUT\_LDOx} = 1mA$	-3.1		+3.1	%

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

# Electrical Characteristics—Low Dropout Linear Regulator (LDO)/Load Switch (LSW) (continued)

 $(V_{IN\_SBB} = V_{IN\_LDO} = V_{SYSA} = 3.7V$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range  $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C)$  are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Dropout Voltage	V <sub>DRP_LDO</sub>	V <sub>IN_LDOx</sub> = 3V, LDOx programmed to 3V, I <sub>OUT_LDOx</sub> = 100mA			100	mV
Line Regulation		$V_{IN\_LDOx} = (V_{OUT\_LDOx} + 0.5 V)$ to 5.5V	-0.5		+0.5	%/V
Load Regulation		V <sub>IN_LDOx</sub> = 1.8V or higher, I <sub>OUT_LDOx</sub> = 100µA to 100mA		0.001	0.005	%/mA
Line Transient		V <sub>IN_LDOx</sub> = 4V to 5V, 5µs rise time		± 35		mV
Land Transient		I <sub>OUT_LDOx</sub> = 100µA to 10mA, 200ns rise time		100		
Load Transient		I <sub>OUT_LDOx</sub> = 100µA to 100mA, 200ns rise time		200		- mV
Active Discharge Resistance	R <sub>AD_LDO</sub>		42	80	200	Ω
		V <sub>IN_LDOx</sub> = 2.7V, I <sub>OUT_LDOx</sub> = 100mA			0.5	Ω
Switch Mode On- Resistance	R <sub>ON_LDO</sub>	V <sub>IN_LDOx</sub> = 1.8V, I <sub>OUT_LDOx</sub> = 50mA			0.8	
		V <sub>IN_LDOx</sub> = 1.2V, I <sub>OUT_LDOx</sub> = 5mA			1.2	
		I <sub>OUT_LDO</sub> = 0mA, time from 10% to 90% of final register value, C <sub>OUT_LDO</sub> = 1μF		2.2		V/ms
Slew Rate		$I_{OUT\_LDO}$ = 0mA, time from 10% to 90% of final register value, $C_{OUT\_LDO}$ = 1µF, switch mode		2.2		
Short Circuit Current		$V_{IN\_LDOX} = 2.7V, V_{OUT\_LDOX} = GND$	230	550	880	
Limit		V <sub>IN_LDOx</sub> = 2.7V, V <sub>OUT_LDOx</sub> = 2.55V, switch mode	230	550		mA
		10Hz to 100kHz, $V_{IN\_LDOx} = 5V$ , $V_{OUT\_LDOx} = 3.3V$		150		
Output Noise		10Hz to 100kHz, $V_{IN\_LDOx} = 5V$ , $V_{OUT\_LDOx} = 2.5V$		125		
		10Hz to 100kHz, V <sub>IN_LDOx</sub> = 5V, V <sub>OUT_LDOx</sub> = 1.2V		90		μV <sub>RMS</sub>
		$10Hz to 100kHz, V_{IN_LDOx} = 5V, V_{OUT_LDOx} = 0.9V$		80		
Output DAC Bits				8		bits
Output DAC LSB Size				25		mV

### Electrical Characteristics—I<sup>2</sup>C Serial Communication

 $(V_{IN} = 3.7V, V_{IO} = 1.8V)$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range ( $T_A = -40^{\circ}C$  to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
V <sub>IO</sub> Voltage Range	V <sub>IO</sub>		1.7	1.8	3.6	V

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## Electrical Characteristics—I<sup>2</sup>C Serial Communication (continued)

 $(V_{IN} = 3.7V, V_{IO} = 1.8V)$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range ( $T_A = -40^{\circ}C$  to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>IO</sub> Bias Current		$V_{IO} = 3.6V, V_{SDA} = V_{SCL} = 0V \text{ or } 3.6V, T_A = +25^{\circ}C$	-1	0	+1	μA
		V <sub>IO</sub> = 1.7V, V <sub>SDA</sub> = V <sub>SCL</sub> = 0V or 1.7V	-1	0	+1	
SDA AND SCL I/O STAG	E					
SCL, SDA Input High Voltage	V <sub>IH</sub>	V <sub>IO</sub> = 1.7V to 3.6V	0.7 x V <sub>IO</sub>			V
SCL, SDA Input Low Voltage	V <sub>IL</sub>	V <sub>IO</sub> = 1.7V to 3.6V			0.3 x V <sub>IO</sub>	V
SCL, SDA Input Hysteresis	V <sub>HYS</sub>			0.05 x V <sub>IO</sub>		V
SCL, SDA Input Leakage Current	Ц	$V_{IO}$ = 3.6V, $V_{SCL}$ = $V_{SDA}$ = 0V and 3.6V	-10		+10	μA
SDA Output Low Voltage	V <sub>OL</sub>	Sinking 20mA			0.4	V
SCL, SDA Pin Capacitance	CI			10		pF
Output Fall Time from V <sub>IH</sub> to V <sub>IL</sub>	t <sub>OF</sub> (Note 5)				120	ns
I <sup>2</sup> C COMPATIBLE INTER	FACE TIMING (	STANDARD, FAST AND FAST MODE PLU	S) (Note 5)			
Clock Frequency	f <sub>SCL</sub>		0		1000	kHz
Hold Time (REPEATED) START Condition	<sup>t</sup> HD_STA		0.26			μs
SCL Low Period	tLOW		0.5			μs
SCL High Period	<sup>t</sup> HIGH		0.26			μs
Setup Time REPEATED START Condition	<sup>t</sup> SU_STA		0.26			μs
Data Hold Time	<sup>t</sup> HD_DAT		0			μs
Data Setup Time	<sup>t</sup> SU_DAT		50			ns
Setup Time for STOP Condition	tsu_sto		0.26			μs
Bus Free Time between STOP and START Condition	<sup>t</sup> BUF		0.5			μs
Pulse Width of Suppressed Spikes	t <sub>SP</sub>	Maximum pulse width of spikes that must be suppressed by the input filter		50		ns
I <sup>2</sup> C COMPATIBLE INTER	FACE TIMING (	HIGH-SPEED MODE, C <sub>B</sub> = 100pF) (Note 5	)			
Clock Frequency	f <sub>SCL</sub>				3.4	MHz
Setup Time REPEATED START Condition	<sup>t</sup> SU_STA		160			ns
Hold Time (REPEATED) START Condition	<sup>t</sup> HD_STA		160			ns
SCL Low Period	tLOW		160	-		ns

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### Electrical Characteristics—I<sup>2</sup>C Serial Communication (continued)

 $(V_{IN} = 3.7V, V_{IO} = 1.8V)$ , limits are 100% production tested at  $T_A = +25^{\circ}C$ , limits over the operating temperature range ( $T_A = -40^{\circ}C$  to +125°C) are guaranteed by design and characterization, unless otherwise noted.)

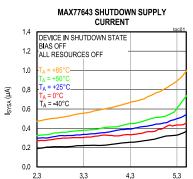
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SCL High Period	thigh		60			ns
Data Setup Time	<sup>t</sup> SU_DAT		10			ns
Data Hold Time	thd_dat		0		70	ns
SCL Rise Time	t <sub>rCL</sub>	T <sub>A</sub> = +25°C	10		40	ns
Rise Time of SCL Signal After REPEATED START Condition and After Acknowledge Bit	<sup>t</sup> rCL1	T <sub>A</sub> = +25°C	10		80	ns
SCL Fall Time	t <sub>fCL</sub>	T <sub>A</sub> = +25°C	10		40	ns
SDA Rise Time	t <sub>rDA</sub>	T <sub>A</sub> = +25°C	10		80	ns
SDA Fall Time	t <sub>fDA</sub>	T <sub>A</sub> = +25°C	10		80	ns
Setup Time for STOP Condition	tsu_s⊤o		160			ns
Bus Capacitance	CB				100	pF
Pulse Width of Suppressed Spikes	t <sub>SP</sub>	Maximum pulse width of spikes that must be suppressed by the input filter		10		ns
I <sup>2</sup> C COMPATIBLE INTER	FACE TIMING (	HIGH-SPEED MODE, C <sub>B</sub> = 400pF) (Note 5)				Į.
Clock Frequency	f <sub>SCL</sub>				1.7	MHz
Setup Time REPEATED START Condition	t <sub>SU_STA</sub>		160			ns
Hold Time (REPEATED) START Condition	t <sub>HD_STA</sub>		160			ns
SCL Low Period	tLOW		320			ns
SCL High Period	tHIGH		120			ns
Data Setup Time	<sup>t</sup> SU_DAT		10			ns
Data Hold Time	thd_dat		0		150	ns
SCL Rise Time	t <sub>RCL</sub>	T <sub>A</sub> = +25°C	20		80	ns
Rise Time of SCL Signal After REPEATED START Condition and After Acknowledge Bit	<sup>t</sup> RCL1	T <sub>A</sub> = +25°C	20		80	ns
SCL Fall Time	t <sub>FCL</sub>	T <sub>A</sub> = +25°C	20		80	ns
SDA Rise Time	t <sub>RDA</sub>	T <sub>A</sub> = +25°C	20		160	ns
SDA Fall Time	t <sub>FDA</sub>	T <sub>A</sub> = +25°C	20		160	ns
Setup Time for STOP Condition	tsu_s⊤o		160			ns
Bus Capacitance	CB				400	pF
Pulse Width of Suppressed Spikes	t <sub>SP</sub>	Maximum pulse width of spikes that must be suppressed by the input filter		10		ns

**Note 5:** Design guidance only. Not production tested.

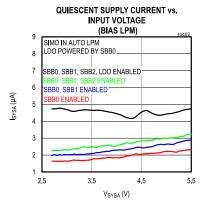
### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

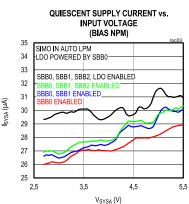
#### **Typical Operating Characteristics**

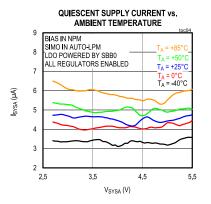
(Typical Applications Circuit. V<sub>SYSA</sub> = 3.7V, V<sub>IO</sub> = 1.8V, T<sub>A</sub> = +25°C, unless otherwise noted. Inductor = DFE201612E-1R5M, 1.5µH, 72mΩ)

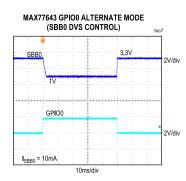


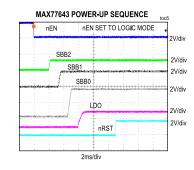
V<sub>SYSA</sub> (V)

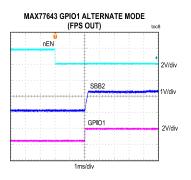


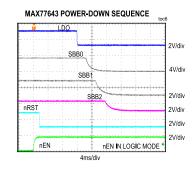


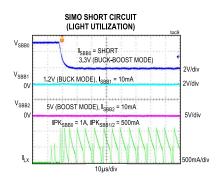








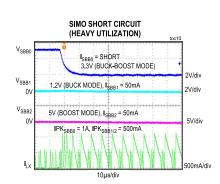


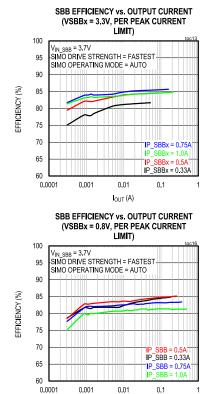


### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

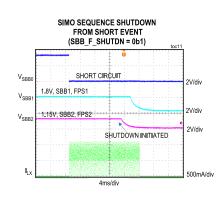
#### Typical Operating Characteristics (continued)

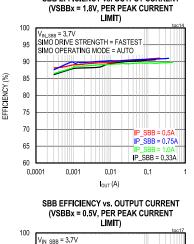
(Typical Applications Circuit. V<sub>SYSA</sub> = 3.7V, V<sub>IO</sub> = 1.8V, T<sub>A</sub> = +25°C, unless otherwise noted. Inductor = DFE201612E-1R5M, 1.5µH, 72mΩ)

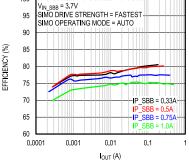


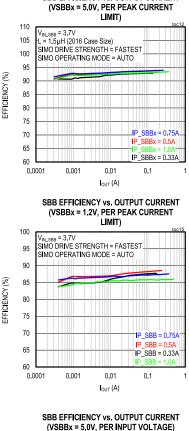


I<sub>OUT</sub> (A)

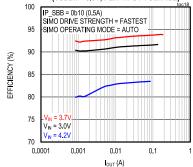








SBB EFFICIENCY vs. OUTPUT CURRENT

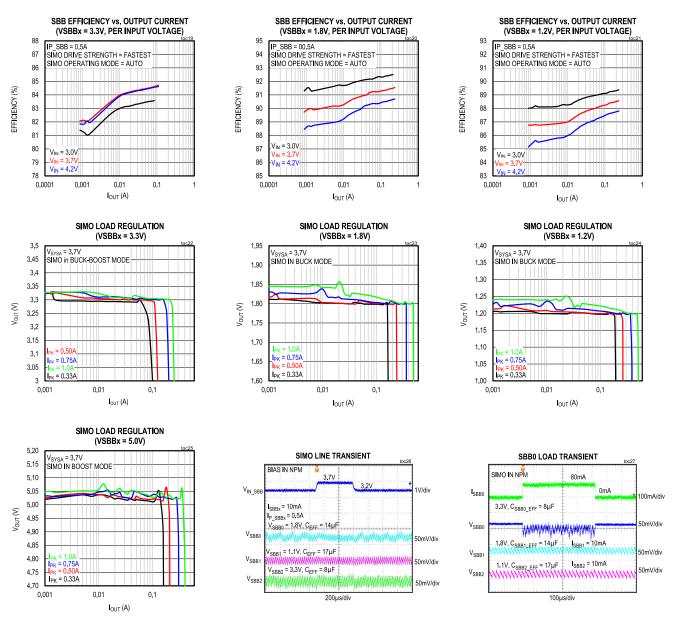


SBB EFFICIENCY vs. OUTPUT CURRENT

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Typical Operating Characteristics (continued)**

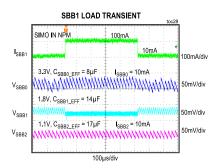
(Typical Applications Circuit.  $V_{SYSA}$  = 3.7V,  $V_{IO}$  = 1.8V,  $T_A$  = +25°C, unless otherwise noted. Inductor = DFE201612E-1R5M, 1.5µH, 72m $\Omega$ )

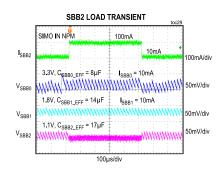


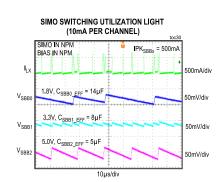
### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

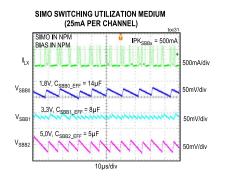
#### **Typical Operating Characteristics (continued)**

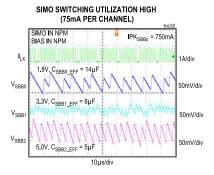
(Typical Applications Circuit.  $V_{SYSA}$  = 3.7V,  $V_{IO}$  = 1.8V,  $T_A$  = +25°C, unless otherwise noted. Inductor = DFE201612E-1R5M, 1.5µH, 72m $\Omega$ )

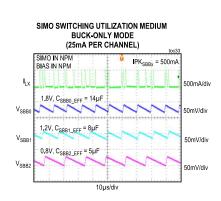


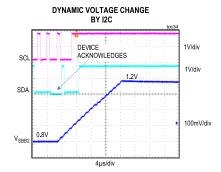


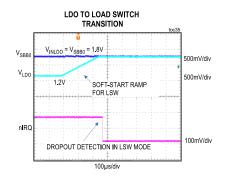


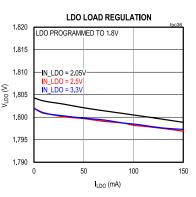








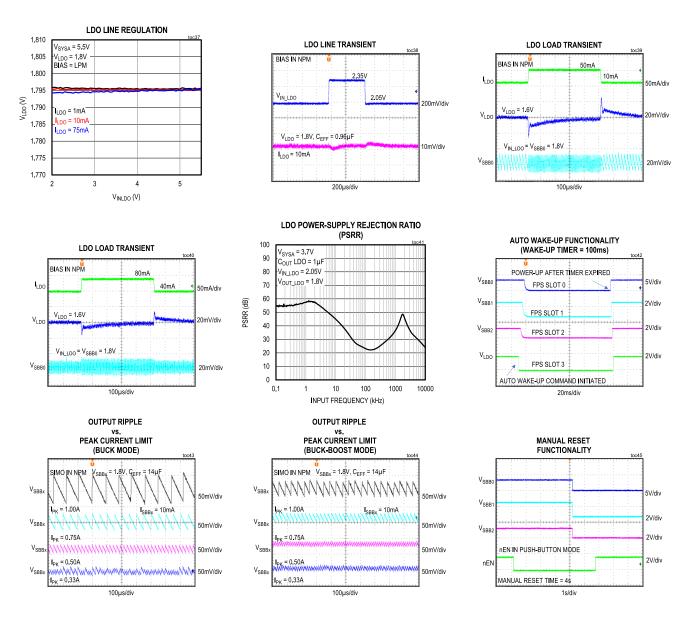




### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Typical Operating Characteristics (continued)**

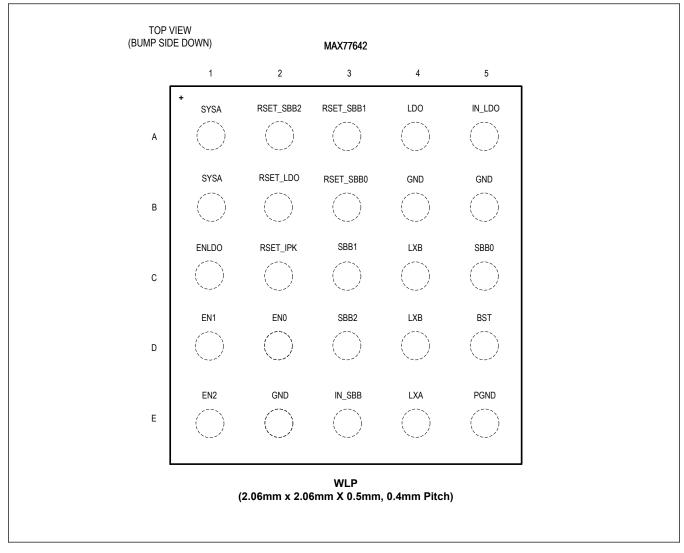
(Typical Applications Circuit.  $V_{SYSA}$  = 3.7V,  $V_{IO}$  = 1.8V,  $T_A$  = +25°C, unless otherwise noted. Inductor = DFE201612E-1R5M, 1.5µH, 72m $\Omega$ )



### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

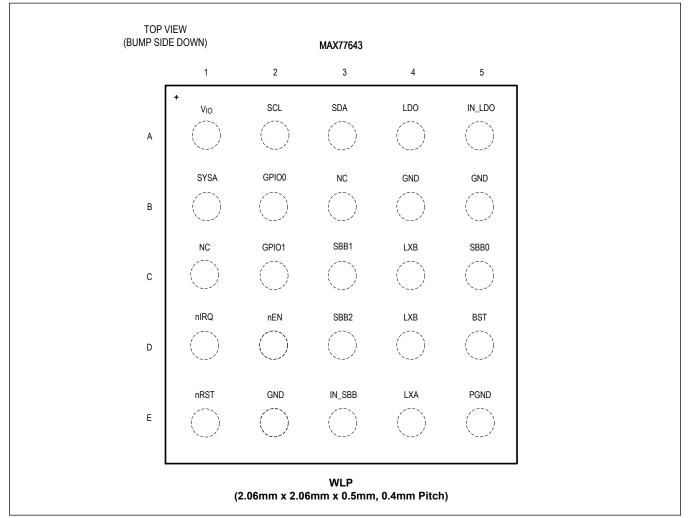
#### **Pin Configurations**

#### MAX77642



### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### MAX77643



#### **Pin Description**

P	IN	NAME		
MAX77642	MAX77643	NAME	FUNCTION	TYPE
TOP LEVEL				
	A1	V <sub>IO</sub>	I <sup>2</sup> C Interface and GPIO Driver Power	Power Input
_	D2	nEN	Active-Low Enable Input. EN supports push-button or slide-switch configurations. If not used, connect nEN to SYS and use the CNFG_SBBx_B.EN_SBBx[2:0] and CNFG_LDO_B.EN_LDO[2:0] bitfields to enable channels.	Digital Input
_	D1	nIRQ	Active-Low, Open-Drain Interrupt Output. Connect a 100k $\Omega$ pullup resistor between $\overline{IRQ}$ and a voltage equal to or less than V_SYSA.	Digital Output
_	E1	nRST	Active-Low, Open-Drain Reset Output. Connect a $100k\Omega$ pullup resistor between nRST and a voltage equal to or less than $V_{SYSA}$ .	Digital Output

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Pin Description (continued)**

PIN		NAME	FUNCTION	TVDE
MAX77642	7642 MAX77643 N		FUNCTION	TYPE
	C2	GPIO1	General Purpose Input/Output. The GPIO I/O stage is internally biased with $\rm V_{IO}.$	Digital I/O
	B2	GPIO0	General Purpose Input/Output. The GPIO I/O stage is internally biased with $\rm V_{IO}.$	Digital I/O
	A2	SCL	I <sup>2</sup> C Clock	Digital Input
	A3	SDA	I <sup>2</sup> C Data	Digital I/O
B4, B5, E2	B4, B5, E2	GND	Quiet Ground. Connect GND to PGND, and the low-impedance ground plane of the PCB.	Ground
A2	—	RSET_SBB2	Select Resistor Pin SBB2. Connect a resistor from this pin to GND, using the value to configure the output voltage of SBB2.	Resistor Input
A3	—	RSET_SBB1	Select Resistor Pin SBB1. Connect a resistor from this pin to GND, using the value to configure the output voltage of SBB1.	Resistor Input
В3	_	RSET_SBB0	Select Resistor Pin SBB0. Connect a resistor from this pin to GND, using the value to configure the output voltage of SBB0.	Resistor Input
B2	_	RSET_LDO	Select Resistor Pin LDO. Connect a resistor from this pin to GND, using the value to configure the output voltage of LDO0.	Resistor Input
C2	_	RSET_IPK	Select Resistor Pin IPK. Connect a resistor from this pin to GND, using the value to configure the peak inductor current.	Resistor Input
D2	_	EN0	Enable Input for SBB0. Hold high to enable output regulation. Hold low to disable the output.	Digital Input
D1	—	EN1	Enable Input for SBB1. Hold high to enable output regulation. Hold low to disable the output.	Digital Input
E1	_	EN2	Enable Input for SBB2. Hold high to enable output regulation. Hold low to disable the output.	Digital Input
	C1, B3	NC	Not Connected	No Connect
C1	—	ENLDO	Enable Input for LDO. Hold high to enable output regulation. Hold low to disable the output.	Digital Input
SIMO BUCK-B	BOOST			
C5	C5	SBB0	SIMO Buck-Boost Output 0. SBB0 is the power output for channel 0 of the SIMO buck-boost. Bypass SBB0 to PGND with a $10\mu$ F ceramic capacitor. If not used, see the <u>Unused Outputs</u> section.	Power Output
C3	C3	SBB1	SIMO Buck-Boost Output 1. SBB1 is the power output for channel 1 of the SIMO buck-boost. Bypass SBB1 to PGND with a $10\mu$ F ceramic capacitor. If not used, see the <u>Unused Outputs</u> section.	Power Output
D3	D3	SBB2	SIMO Buck-Boost Output 2. SBB2 is the power output for channel 2 of the SIMO buck-boost. Bypass SBB0 to PGND with a $10\mu$ F ceramic capacitor. If not used, see the <u>Unused Outputs</u> section.	Power Output
D5	D5	BST	SIMO Power Input for the High-Side Output NMOS Drivers. Connect a 10nF ceramic capacitor between BST and LXB.	Power Input
C4, D4	C4, D4	LXB	Switching Node B. LXB is driven between PGND and SBBx when SBBx is enabled. LXB is driven to PGND when all SIMO channels are disabled. Connect a 1.5µH inductor between LXA and LXB.	Power Input

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Pin Description (continued)**

P	IN	NAME	FUNCTION	ТҮРЕ
MAX77642	MAX77643			
E4	E4	LXA	Switching Node A. LXA is driven between PGND and IN_SBB when any SIMO channel is enabled. LXA is driven to PGND when all SIMO channels are disabled. Connect a 1.5µH inductor between LXA and LXB.	
E5	E5	PGND	Power Ground for the SIMO Low-Side FETs. Connect PGND to GND, and the low-impedance ground plane of the PCB.	Ground
A1, B1	B1	SYSA	Analog Input Supply. Connect to V <sub>IN_SBB</sub> .	Power Input
E3	E3	IN_SBB	SIMO Power Input. Connect IN_SBB to SYSA and bypass to PGND with a minimum of $10\mu$ F ceramic capacitor as close as possible to the IN_SBB pin.	Power Input
LDO				
A5	A5	IN_LDO	Linear Regulator Input. If connected to a SIMO output with a short trace, IN_LDO can share the output's capacitor. Otherwise, bypass with a $2.2\mu$ F ceramic capacitor to ground. If not used, connect to ground or leave unconnected.	Power Input
A4	A4	LDO	Linear Regulator Output. Bypass with a $1.0\mu$ F ceramic capacitor to GND. If not used, disable LDO and connect this pin to ground or leave unconnected.	Power Output

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#### **Detailed Description**

The MAX77642/MAX77643 provide highly-integrated power management solutions for low-power applications.

Four regulators are integrated within this device (see <u>Table 1</u>). A single-inductor, multiple output (SIMO) buck-boost regulator efficiently provides three independently programmable power rails. A 150mA low-dropout linear regulator (LDO) provides ripple rejection for audio and other noise sensitive applications.

The MAX77643 includes other features such as two GPIOs with alternate modes for various system requirements. A bidirectional I<sup>2</sup>C serial interface allows for configuring and checking the status of the device. An internal on/off controller provides regulator sequencing and supervisory functionality for the device.

#### **Table 1. Regulator Summary**

REGULATOR NAME	REGULATOR TOPOLOGY	MAXIMUM I <sub>OUT</sub> (mA)	V <sub>IN</sub> RANGE (V)	MAX77643 V <sub>OUT</sub> RANGE/ RESOLUTION
SBB0	SIMO		2.7 to 5.5	0.5V to 5.5V in 25mV steps
SBB1	SIMO	Up to 500*	2.7 to 5.5	0.5V to 5.5V in 25mV steps
SBB2	SIMO		2.7 to 5.5	0.5V to 5.5V in 25mV steps
LDO	PMOS LDO	150	1.7 to 5.5	0.5V to 5.0V in 25mV steps

\*Shared capacity with other SBBx channels. See the SIMO Available Output Current section for more information.

#### Part Number Decoding

The MAX77643 has different one-time programmable (OTP) options and variants to support a variety of applications. The OTP options set default settings such as output voltage. Variants are versions of the MAX77643 with different features. See Figure 1 for how to identify these. <u>Table 2</u> and <u>Table 3</u> list all available OTP options and variants. Refer to <u>Maxim</u> <u>Products Naming Convention</u> for more details.

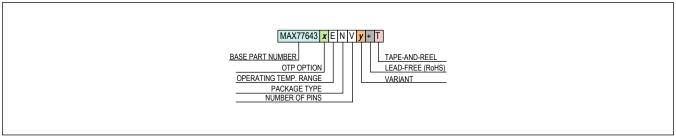


Figure 1. Part Number Decode

#### **Table 2. Variants Table**

PART NUMBER	MAX77642	MAX77643
Resistor Programmable Output Voltages	Yes	No
Resistor Programmable Peak Current	Yes	No
Supports LDO/LSW	Yes	Yes
Include GPIOs	No	Yes
Individual Enable Pins for LDO and SIMO Outputs	Yes	No
Programmable Flexible Power Sequencer	No	Yes
Watchdog Timer	No	Yes
Supports I <sup>2</sup> C Serial Communication	No	Yes

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### Table 3. OTP Options Table

			OTP LETTER AND SETTINGS
		VARIANT	NONE
BLOCK	BIT FIELD NAME	SETTING NAME	Α
	MRST	Manual Reset Time	4s
	nEN_MODE	On-Key Default Configuration	Logic-Mode
	DBEN_nEN	Debounce Timer for nEN	500µs
	SFT_CTRL	Software Reset Functions	No Action
	ALT_GPIO0	GPIO0 Mode	GPIO
	ALT_GPIO1	GPIO1 Mode	GPIO
Global	SBB_F_SHUTDN	SBB Shutdown from SBB Fault	SBB Does Not Shut Off
	ADDR	I <sup>2</sup> C Address (7-bit)	0x48
	UVLO_F[3:0]	UVLO Falling	2.6V
	UVLO_H[3:0]	UVLO Hysteresis	0.3V
	DIDM	Device ID for Metal Options	0b0
	CID[4]	Chip ID	0x00
	CID[3:0]	Chip ID	0x02
Watchdog –	WDT_LOCK	Watchdog Timer Disable Control	Unlocked
	WDT_EN	Watchdog Timer Enable	Disabled
	TV_SBB0[6:0]	SBB0 V <sub>OUT</sub>	3.050V
	IP_SBB0[1:0]	SBB0 Inductor Current Peak Limit	0.75A
	OP_MODE (SBB0)	SBB0 Operating Mode	Buck-Boost
	ADE_SBB0	Active-Discharge Resistor Enable	Enabled
	EN_SBB0[2:0]	SBB0 Enable Control	FPS Slot 0
	TV_SBB1[6:0]	SBB1 V <sub>OUT</sub>	1.800V
	IP_SBB1[1:0]	SBB1 Inductor Current Peak Limit	0.333A
SIMO	OP_MODE (SBB1)	SBB1 Operating Mode	Buck-Boost
	ADE_SBB1	Active-Discharge Resistor Enable	Enabled
	EN_SBB1[2:0]	SBB1 Enable Control	ON
	TV_SBB2[6:0]	SBB2 V <sub>OUT</sub>	1.200V
	IP_SBB2[1:0]	SBB2 Inductor Current Peak Limit	0.333A
	OP_MODE (SBB2)	SBB2 Operating Mode	Buck-Boost
l l	ADE_SBB2	Active-Discharge Resistor Enable	Enabled
	EN_SBB2[2:0]	SBB2 Enable Control	FPS Slot 2
	TV_LDO[6:0]	LDO V <sub>OUT</sub>	2.800V
LDO	LDO_MD	LDO or LSW Mode	LDO
	ADE_LDO	Active-Discharge Resistor Enable	Enabled

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **Detailed Description—Global Resources**

The global resources encompass a set of circuits that serve the entire device and ensure safe, consistent, and reliable operation.

#### Features and Benefits

- Voltage Monitors
  - IN power-on-reset (POR) comparator generates a reset signal upon power-up
  - · IN undervoltage ensures repeatable behavior when power is applied to and removed from the device
  - · IN overvoltage monitor inhibits operation with overvoltage power sources to ensure reliability in faulty environments
- Thermal Monitors
  - +145°C junction temperature shutdown
- Manual Reset
- 4s or 8s period
- Wake-Up Events
  - nEN input assertion
- Interrupt Handler
  - Interrupt output (nIRQ)
  - · All interrupts are maskable
- Push-Button/Slide-Switch/Logic Mode On-Key (nEN)
  - Configurable push-button/slide-switch functionality
  - · 500µs or 30ms debounce timer interfaces directly with mechanical switches
- On/Off Controller
  - Startup/shutdown sequencing
  - · Programmable sequencing delay
- GPIO, nRST Digital I/Os

#### Voltage Monitors

The device monitors the system voltage (V<sub>SYSA</sub>) to ensure proper operation using three comparators (POR, UVLO, and OVLO). These comparators include hysteresis to prevent their outputs from toggling between states during noisy system transitions.

#### SYSA POR Comparator

The SYSA POR comparator monitors  $V_{SYSA}$  and generates a power-on reset (POR) signal. When  $V_{SYSA}$  is below  $V_{POR}$ , the device is held in reset (SYSARST = 1). When  $V_{SYSA}$  rises above  $V_{POR}$ , internal signals and on-chip memory stabilize and the device is released from reset (SYSRST = 0).

#### SYSA Undervoltage-Lockout Comparator

The SYSA undervoltage-lockout (UVLO) comparator monitors  $V_{SYSA}$  and generates a SYSAUVLO signal when the  $V_{SYSA}$  falls below UVLO threshold. The SYSAUVLO signal is provided to the top-level digital controller. See Figure 6, Table 5, Figure 7, and Table 6 for additional information regarding the UVLO comparator.

#### SYSA Overvoltage-Lockout Comparator

The device is rated for 5.5V maximum operating voltage ( $V_{SYSA}$ ) with an absolute maximum input voltage of 6.0V. An overvoltage-lockout monitor increases the robustness of the device by inhibiting operation when the supply voltage is greater than  $V_{SYSAOVLO}$ . See <u>Figure 6</u>, <u>Table 5</u>, <u>Figure 7</u>, and <u>Table 6</u> for additional information regarding the OVLO comparator.

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#### **Thermal Monitors**

The MAX77643 has three global on-chip thermal sensors:

- Junction Temperature Alarm  $1 \rightarrow 80^{\circ}C$
- Junction Temperature Alarm 2  $\rightarrow$  100°C
- Junction Temperature Shutdown  $\rightarrow$  145°C

The junction temperature alarms have maskable rising interrupts as well as status bits (see the Register Map section for more information). Unmasking these thermal alarms is recommended for all systems. If the first alarm is triggered, the system software should attempt to lower system power dissipation. If the second alarm is triggered, then attempts to lower the power dissipation were unsuccessful and the system software should turn the device off. Finally, if the junction temperature rises to junction temperature shutdown, then the MAX77643 sets the ERCFLAG.TOVLD bit and automatically turns itself off.

After a junction temperature shutdown event, the system can be enabled again. The system software can read the ERCFLAG register during initialization to see ERCFLAG.TOVLD = 1 and log that an extreme thermal event has occurred.

#### **Chip Identification**

The MAX77643 offers different one-time-programmable (OTP) options to, for example, set the default output voltages. These options are identified by the chip identification number, which can be read in the CID register.

#### nEN Enable Input (MAX77643)

The nEN is an active-low internally debounced digital input that typically comes from the system's on-key. The debounce time is programmable with CNFG\_GLBLx.DBEN\_nEN. The primary purpose of this input is to generate a wake-up signal for the PMIC that turns on the regulators. Maskable rising/falling interrupts are available for nEN (INT\_GLBLx.nEN\_R and INT\_GLBLx.nEN\_F) for alternate functionality.

The nEN input can be configured to work either with a push-button (CNFG\_GLBL0.nEN\_MODE = 0b00), a slideswitch (CNFG\_GLBL0.nEN\_MODE = 0b01), or Logic Mode (CNFG\_GLBL0.nEN\_MODE = 0b10). See <u>Figure 3</u> for more information. In both push-button mode and slide-switch mode, the on/off controller looks for a falling edge on the nEN input to initiate a power-up sequence.

#### EN Enable Input (MAX77642)

The MAX77642 features three enable pins to individually control the on/off state of the SIMO outputs. Drive each enable pin high to turn its respective SIMO output on. Each enable pin has a 50nA pulldown current to ground (as shown in Figure 2). The pins can be tied high for always on-applications. Do not leave the EN pins unconnected.

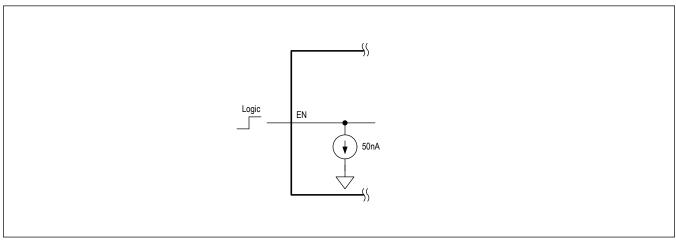


Figure 2. EN Pulldown

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#### nEN Manual Reset (MAX77643)

The nEN works as a manual reset input when the on/off controller is in the "Resource-On" state. The manual reset function is useful for forcing a power-down in case communication with the processor fails. When nEN is configured for push-button mode and the input is asserted (nEN = LOW) for an extended period ( $t_{MRST}$ ), the on/off controller initiates a power-down sequence and goes to shutdown mode. When nEN is configured for slide-switch mode and the input is deasserted (nEN = HIGH) for an extended period ( $t_{MRST}$ ), the on/off controller initiates a power-down sequence and goes to standby mode. When nEN is configured as a logic mode, the on/off controller initiates a power-up sequence and goes into Resource ON mode when the input is asserted (nEN = LOW). When the input is deasserted (nEN = LOW), the on/off controller initiates a power-down sequence and goes into Resource ON mode when the input is asserted (nEN = LOW). When the input is deasserted (nEN = LOW), the on/off controller initiates a power-down sequence and goes into shutdown mode.

#### nEN Triple-Functionality: Push-Button vs. Slide-Switch vs. Logic (MAX77643)

The nEN digital input can be configured to work with a push-button, a slide-switch, or a logic input. Figure 3 shows nEN's triple functionality for power-on sequencing and manual reset. The default configuration of the device is push-button mode (CNFG\_GLBL0.nEN\_MODE = 0b00) and no additional programming is necessary. Applications that use a slide-switch on-key and logic configuration must set CNFG\_GLBL0.nEN\_MODE = 0b01 and CNFG\_GLBL0.nEN\_MODE = 0b10 respectively within  $t_{MRST}$ .

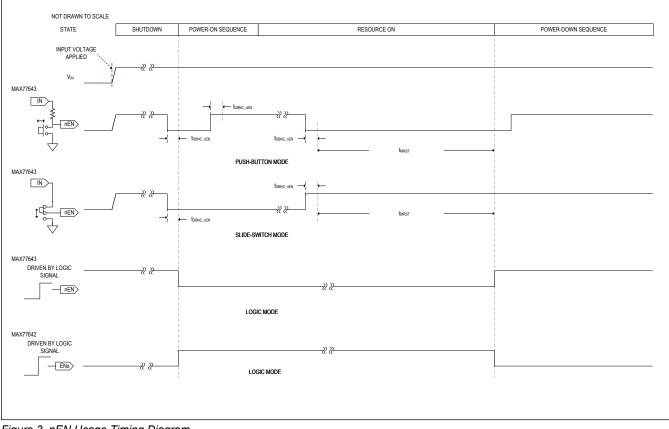


Figure 3. nEN Usage Timing Diagram

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#### nEN Internal Pullup Resistors to VSYSA

The nEN logic thresholds are referenced to V<sub>SYSA</sub>. There are internal pullup resistors between nEN and V<sub>SYSA</sub> ( $R_{nEN_PU}$ ), which can be configured with the CNFG\_GLBL0.PU\_DIS bit. See <u>Figure 4</u>. While PU\_DIS = 0, the pullup value is approximately 200k $\Omega$ . While PU\_DIS = 1, the pullup value is 10M $\Omega$ .

Applications using a slide-switch on-key or push-pull digital output connected to nEN can reduce quiescent current consumption by changing pullup strength to  $10M\Omega$ . Applications using normally-open, momentary, and push-button on-keys (as shown in Figure 4) do not create this leakage path and should use the stronger  $200k\Omega$  pullup option.

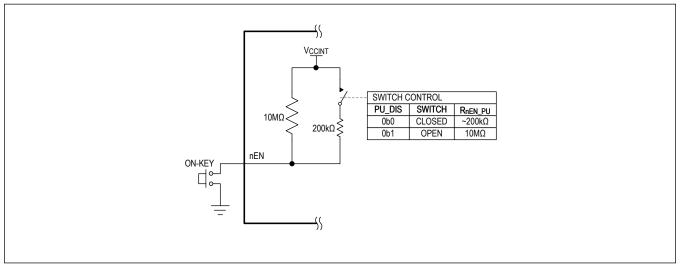


Figure 4. nEN Pullup Resistor Configuration

#### Interrupts (nIRQ) (MAX77643)

The nIRQ (MAX77643) is an active-low, open-drain output that is typically routed to the host processor's interrupt input to signal an important change in device status. See the *Register Map* section for a comprehensive list of all interrupt bits and status registers.

A pullup resistor to a voltage less than or equal to V<sub>SYSA</sub> is required for this node. The nIRQ is the logical *NOR* of all unmasked interrupt bits in the register map.

All interrupts are masked by default. Masked interrupt bits do not cause the nIRQ pin to change. Unmask the interrupt bits to allow the nIRQ to assert.

#### Reset Output (nRST) (MAX77643)

The nRST (MAX77643) is an open-drain, active-low output that is typically used to hold the processor in a reset state when the device is powered down. During a power-up sequence, the nRST deasserts after the last regulator in the power-up chain is enabled ( $t_{RSTODD}$ ). During a power-down sequence, the nRST output asserts before any regulator is powered down ( $t_{RSTOAD}$ ). See Figure 11 for nRST timing.

A pullup resistor to a voltage less than or equal to V<sub>SYSA</sub> is required for this node.

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#### General-Purpose Input Output (GPIO) (MAX77643)

The MAX77643 provides two general-purpose input/output (GPIO) pins increase system flexibility. See Figure 5 for more details.

Clear CNFG\_GPIOx.DIR = 0b0 to configure GPIO as a general-purpose output (GPO). The GPO can either be in pushpull mode (CNFG\_GPIOx.DRV = 1) or open-drain mode (CNFG\_GPIOx.DRV = 0).

- The push-pull output mode is ideal for applications that need fast (~2ns) edges and low power consumption.
- The open-drain mode requires an external pullup resistor (typically  $10k\Omega$  to  $100k\Omega$ ). Connect the external pullup resistor to a bias voltage that is less than or equal to V<sub>IO</sub>.
  - The open-drain mode can be used to communicate to different logic domains. For example, to send a signal from the GPO on a 1.8V logic domain ( $V_{IO}$  = 1.8V) to a device on a 1.2V logic domain, connect the external pullup resistor to 1.2V.
  - The open-drain mode can be used to connect several open-drain (or open-collector) devices together on the same bus to create wired logic (wired AND logic is positive-true; wired OR logic is negative-true).
- The general-purpose input (GPI) functions are still available while the pin is configured as a GPO. In other words, the CNFG\_GPIOx.DI (input status) bit still functions and does not collide with the state of the CNFG\_GPIOx.DIR bit.

Set CNFG\_GPIOx.DIR to have the GPIO function as a GPI. The GPI features a 30ms debounce timer ( $t_{DBNC_GPI}$ ) that can be enabled or disabled with DBEN\_GPI.

- Enable the debounce timer (CNFG\_GPIOx.DBEN\_GPI = 1) if the GPI is connected to a device that can bounce or chatter, like a mechanical switch.
- If the GPI is connected to a circuit with clean logic transitions and no risk of bounce, disable the debounce timer (CNFG\_GPIOx.DBEN\_GPI = 0) to eliminate logic delays. With no debounce timer, the GPI input logic propagates to nIRQ in 10ns.

A dedicated internal oscillator is used to create the 30ms ( $t_{DBNC\_GPI}$ ) debounce timer. To obtain low V<sub>IO</sub> supply current, ensure the GPIO voltage is either logic high or logic low. If the GPIO pin is unconnected (either as a GPI or an open-drain GPO) and V<sub>IO</sub> is powered, the GPIO voltage trends towards the logic level gray area (0.3 x V<sub>IO</sub> < V<sub>GPIO</sub> < 0.7 x V<sub>IO</sub>). If V<sub>GPIO</sub> is in the gray area, V<sub>IO</sub> current can be more than 10µA.

The GPI features edge detectors that feed into the top-level interrupt system of the chip. This allows software to use interrupts to service events associated with a GPI change instead of polling for these changes.

- If the application wants nIRQ to go low **only on a GPI rising edge**, then it should **clear** the GPI rising edge interrupt mask bit (INTM\_GLBLx.GPI\_RM = 0) and **set** the GPI falling edge interrupt mask bit (INTM\_GLBLx.GPI\_FM = 1).
- If the application wants nIRQ to go low **only on a GPI falling edge**, then it should **set** the GPI rising edge interrupt mask bit (INTM\_GLBLx.GPI\_RM = 1) and **clear** the GPI falling edge interrupt mask bit (INTM\_GLBLx.GPI\_FM = 0).
- If the application wants nIRQ to go low on both GPI falling and rising edges, then it should clear the GPI rising edge interrupt mask bit (INTM\_GLBLx.GPI\_RM = 0) and clear the GPI falling edge interrupt mask bit (INTM\_GLBLx.GPI\_FM = 0).

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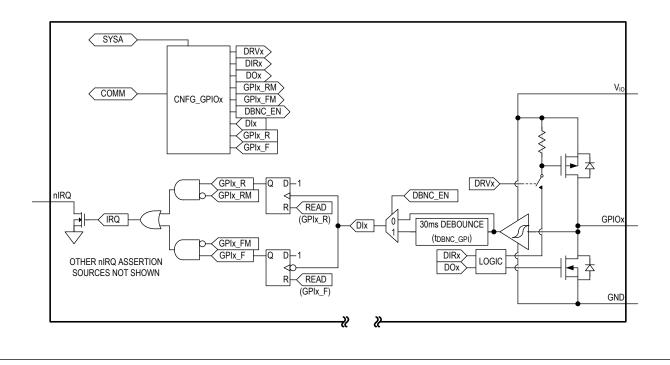


Figure 5. GPIOx Block Diagram

#### Alternate Mode (MAX77643)

The GPIO in the MAX77643 can be configured to have a different function. Whether the GPIO is in GPIO mode or alternate mode can be checked by reading the CNFG\_GPIOx.ALT\_GPIOx bit. <u>Table 4</u> summarizes the alternate functions for each GPIO.

#### Table 4. GPIO MODE

GPIOx	CNFG_GPIOx REGISTER	
	ALT_GPIOx = 0	ALT_GPIOx = 1
GPIO0	Standard GPIO	Active-high input, controls the DVS feature for SBB0.
GPIO1	Standard GPIO	Active-high output of SBB2's flexible power sequencer (FPS) slot.

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **On/Off Controller**

The on/off controller monitors multiple power-up (wake-up) and power-down (shutdown) conditions to enable or disable resources that are necessary for the system and its processor to move between its operating modes.

Many systems have one power management controller and one processor and rely on the on/off controller to be the master controller. In this case, the on/off controller receives wake-up events and enables some or all of the regulators to power up a processor. That processor then manages the system. To conceptualize this master operation, see <u>Figure 7</u> and <u>Table 6</u>. A typical path through the on/off controller is:

- 1. Apply a battery and start in the shutdown state.
- 2. Press the system's on-key (nEN = LOW) and follow transitions 3 and 4 to the resource-on state. If any resources are on the FPS, transitions 5A and 5B are followed.
- 3. The device performs its desired functions in the resource-on state. when it is ready to turn off, a manual reset first drives the transition through transitions 6A and 6B for FPS power down then through the 7 and 0 states to the shutdown state.

Some systems have several power management blocks, a main processor, and subprocessors. These systems can use this device as a subpower management block for a peripheral portion of circuitry as long as there is an  $I^2C$  port available from a higher level processor. To conceptualize this operation, see <u>Figure 7</u> and <u>Table 6</u>. A typical path through the on/ off controller used in this way is:

- 1. Apply a battery to the system and start in the shutdown state.
- 2. The higher level processor can now control this device's resources with I<sup>2</sup>C commands (e.g., turn on/off regulators).
- 3. When the higher level processor is ready to turn this device off, it turns off everything through I<sup>2</sup>C to transition along path 7 to the shutdown state.

Note that in this style of operation, the CNFG\_GLBL0.SFT\_CTRL[1:0] bits should not be used to turn the device off. The CNFG\_GLBL0.SFT\_CTRL[1:0] bits establish directives to the on/off controller itself that does not make sense in this subpower management block operation. If the processor uses I<sup>2</sup>C commands to enable the device's resources, the processor should also use I<sup>2</sup>C commands to disable them.

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### Top Level On/Off Controller (MAX77642)

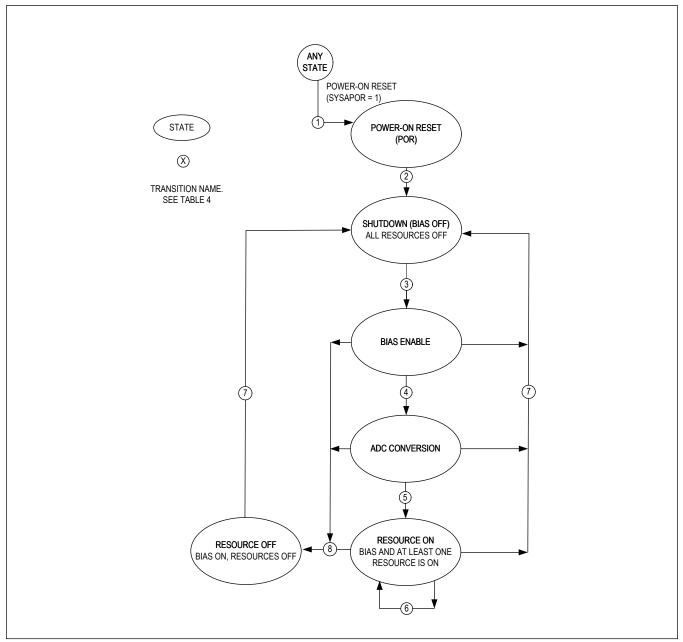


Figure 6. Top Level On/Off Controller State Diagram (MAX77642)

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## On/Off Controller Transition Table (MAX77642)

## Table 5. On/Off Controller Transition/State (MAX77642)

TRANSITION	CONDITION (TRANSITION HAPPENS WHEN)						
1	System voltage is above the POR threshold (V <sub>SYSA</sub> > V <sub>POR</sub> )						
2	$V_{SYSA} \ge V_{SYSA(UVLO_R)}$						
3	First ENx transitions from low to high						
4	Main Bias enable time expires (t <sub>SBIAS_EN</sub> )						
5	ADC detection time expires (t <sub>RSET</sub> )						
6	Additional ENx transitions from low to high OR ENx transitions from high to low (as long as one SIMO channel or the LDO is enabled)						
7	Last ENx transitions from high to low (all SIMO channels and the LDO are disabled)						
8	Chip overtemperature lockout (T <sub>J</sub> > T <sub>OTLO</sub> ) OR SYSA undervoltage lockout (V <sub>SYSA</sub> < V <sub>SYSAUVLO</sub> ) OR SYSA overvoltage lockout (V <sub>SYSA</sub> > V <sub>SYSAOVLO</sub> )						

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### Top Level On/Off Controller (MAX77643)

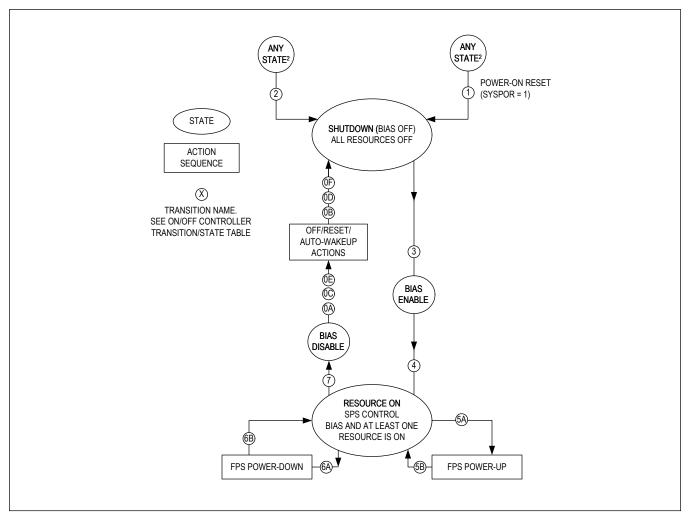


Figure 7. Top Level On/Off Controller State Diagram (MAX77643)

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

#### **On/Off Controller Transition Table (MAX77643)**

## Table 6. On/Off Controller Transition/State (MAX77643)

RANSITION	CONDITION (TRANSITION HAPPENS WHEN)
0A	Software cold reset (CNFG_GLBL0.SFT_CTRL[1:0] = 0b01) OR Watchdog timer expired and caused reset (ERCFLAG.WDT_RST = 1, CNFG_WDT.WDT_MODE = 1)
0B	Reset actions completed
0C	Software power-off (CNFG_GLBL0.SFT_CTRL[1:0] = 0b10) OR Watchdog expired and caused power-off (ERCFLAG.WDT_OFF = 1, CNFG_WDT.WDT_MODE = 0) OR Chip overtemperature lockout ( $T_J > T_{OTLO}$ ) OR SYSA undervoltage lockout ( $V_{SYSA} < V_{SYSAUVLO} + V_{SYSAUVLO_HYS}$ ) OR SYSA overvoltage lockout ( $V_{SYSA} > V_{SYSAOVLO}$ ) OR Manual reset occurred (ERCFLAG.MRST = 1)
0D	Off actions completed
0E	Software auto wake-up (CNFG_GLBL0.SFT_CTRL = 0b11
0F	Auto wake-up actions completed
1	System voltage is above the POR threshold ( $V_{SYSA} > V_{POR}$ ).
2	Chip overtemperature lockout (T <sub>J</sub> > T <sub>OTLO</sub> ) OR SYSA undervoltage lockout (V <sub>SYSA</sub> < V <sub>SYSAUVLO</sub> + V <sub>SYSUVLO_HYS</sub> ) OR SYSA overvoltage lockout (V <sub>SYSA</sub> > V <sub>SYSAOVLO</sub> )
3	Any resources force enabled OR Internal wake-up flags are set (see the <u>Internal Wake-Up Flags (MAX77643)</u> section)
4	Main bias enable time expires (t <sub>SBIAS_EN</sub> ) AND Conditions in Transition 2 are not met.
5A	FPS power-up sequence has not happened yet AND Resources are not forced off AND Internal wake-up flags are set (see the <u>Internal Wake-Up Flags (MAX77643)</u> section)
5B	FPS power-up sequence completed
6A	FPS power-up sequence completed AND Software cold reset (CNFG_GLBL0.SFT_CTRL[1:0] = 0b01) OR Software power-off (CNFG_GLBL0.SFT_CTRL[1:0] = 0b10) OR Software auto wake-up (CNFG_GLBL0.SFT_CTRL = 0b11 OR Watchdog timer expired OR Manual reset occurred (ERCFLAG.MRT = 1) OR CNFG_GLBL1.SBB_F_SHUTDN = 0b1 AND SBB fault occurs
6B	FPS power-down sequence finished
7	Last resource turned off

#### Internal Wake-Up Flags (MAX77643)

After transitioning to the shutdown state because of a reset, to allow the device to power up again, internal wake-up flags are set to remember the wake-up request. In Figure 7 and Table 6, these internal wake-up flags trigger transition 3. The internal wake-up flags are set when any of the following happen:

- nEN is debounced (see the <u>nEN Enable Input (MAX77643)</u> section)
  - For example, after a push-button is pressed or a slide-switch switched to HIGH.
- Software cold reset command sent (CNFG\_GLBL0.SFT\_CTRL[1:0] = 0b01)

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#### Reset, Off, and Auto Wake-Up Sequences (MAX77643)

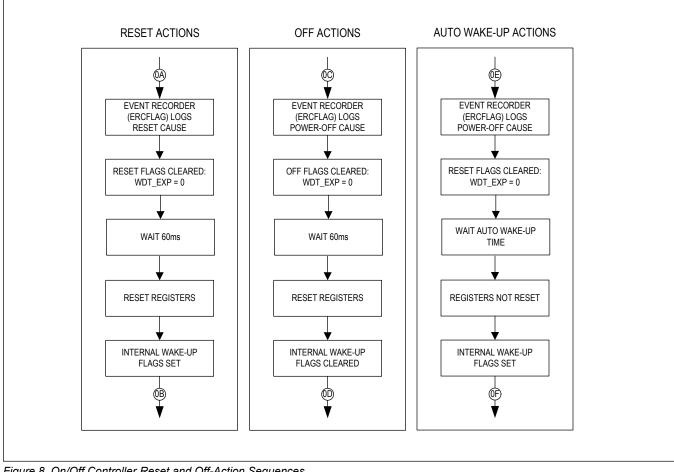


Figure 8. On/Off Controller Reset and Off-Action Sequences

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#### Power-Up/Down Sequence (MAX77643)

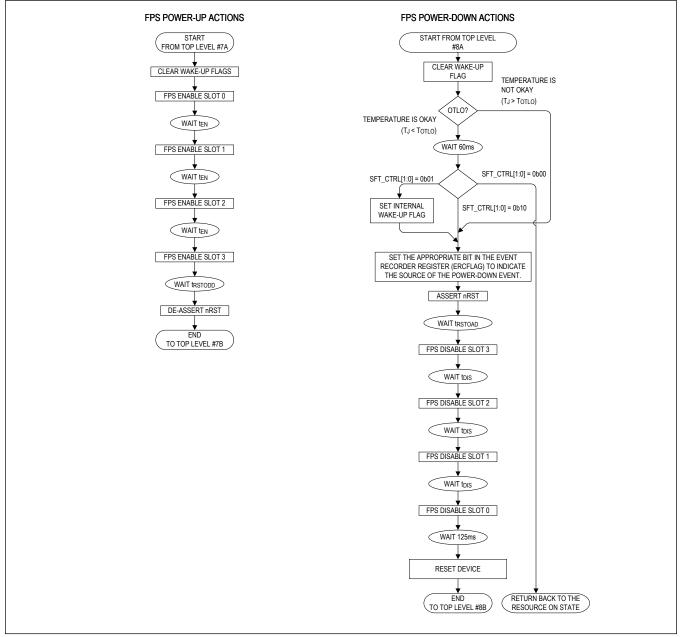


Figure 9. Power-Up/Down Sequence

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#### Flexible Power Sequencer (FPS) (MAX77643)

The FPS allows resources to power up under hardware or software control. Additionally, each resource can power up independently or among a group of other regulators with adjustable power-up/down delays (sequencing). Figure 10 shows four resources powering up under the control of the flexible power sequencer.

The flexible sequencing structure consists of one master sequencing timer and four slave resources (SBB0, SBB1, SBB2 and LDO). When the FPS is enabled, a master timer generates four sequencing events for device power-up/down.

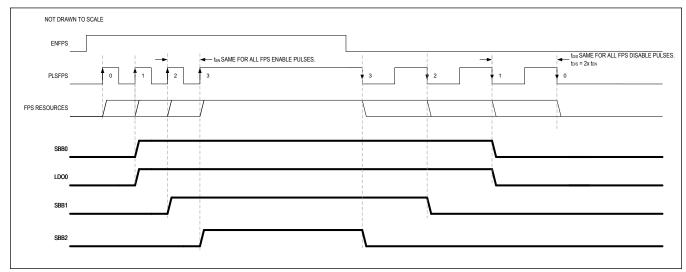
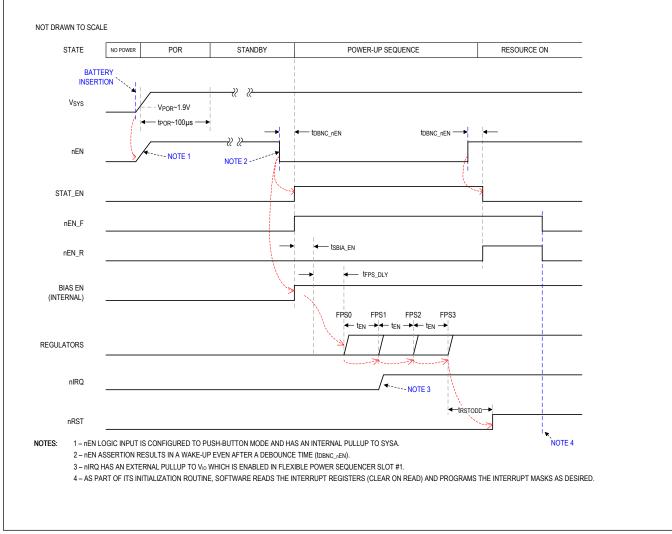


Figure 10. Flexible Power Sequencer Basic Timing Diagram

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### Startup Timing Diagram Due to nEN (MAX77643)

Figure 11. Startup Timing Diagram Due to nEN

#### Force Enabled/Disabled Channels (MAX77643)

Force enable SIMO and LDO output channels by setting CNFG\_SBBx\_B.EN\_SBBx[2:0] (SIMO) or CNFG\_LDOx\_B.EN\_LDOx[2:0] (LDO) = 0x6. Depending on the OTP, output channels may already be force enabled by default. Output channels configured this way are independent of the flexible power sequence and start up as soon as SYS > UVLO rising. The main bias also automatically turns on.

Likewise, output channels can be force disabled by setting EN\_SBBx[2:0] or EN\_LDOx[2:0] = 0x4.

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### Debounced Inputs (nEN, GPI) (MAX77643)

The nEN and GPIO (when operating as an input) have programmable debounce timers on both the rising and falling edges to reject undesired transitions. The input must be at a stable logic level for the entire debounce period for the output to change its logic state. Figure 12 shows an example timing diagram for the nEN debounce.

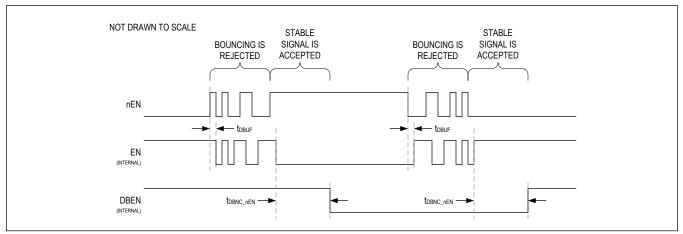


Figure 12. Debounced Inputs

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### Watchdog Timer (WDT) (MAX77643)

The IC features a watchdog timer function for operational safety. If this timer expires without being cleared, the on/off controller causes the IC to enter the shutdown state and resets configuration registers. See the <u>On/Off Controller</u> and <u>On/Off Controller Transition Table (MAX77643)</u> sections (transitions 0A and 0C) for more details.

Write CNFG\_WDT.WDT\_EN = 1 through the  $I^2C$  interface to enable the timer. The watchdog timer period ( $t_{WD}$ ) is configurable from 16 seconds to 128 seconds in four steps with CNFG\_WDT.WDT\_PER[1:0]. The default timer period is 128 seconds. While the watchdog timer is enabled, the CNFG\_WDT.WDT\_CLR bit must be set through the  $I^2C$  interface periodically (within  $t_{WD}$ ) to reset the timer and prevent shutdown. See the *Register Map* and <u>Figure 13</u> for additional details.

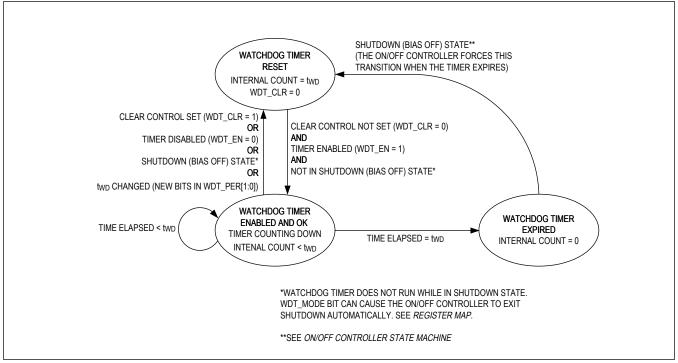


Figure 13. Watchdog Timer State Machine

The timer can be factory-programmed to be enabled by default, disabled by default, or locked from accidental disable. The CNFG WDT.WDT LOCK bit is read-only and must be configured at the factory. See <u>Table 7</u> for a full description.

## Table 7. Watchdog Timer Factory-Programmed Safety Options

WDT_LOCK	WDT_EN	FUNCTION
0	0	Watchdog timer is disabled by default. Timer can be enabled or disabled by I <sup>2</sup> C writes.
0	1	Watchdog timer is enabled by default. Timer can be enabled or disabled by I <sup>2</sup> C writes.
1	0	Watchdog timer is disabled by default. Timer can be enabled by an I <sup>2</sup> C write, but only a SYSRST can reset the CNFG_WDT.WDT_EN value back to 0. Timer can not be disabled by direct I <sup>2</sup> C writes to CNFG_WDT.WDT_EN (write from $1 \rightarrow 0$ is ignored, write from $0 \rightarrow 1$ is accepted).
1	1	Watchdog timer is enabled by default. Nothing can disable the timer.

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## **Detailed Description—SIMO Buck-Boost**

The device has a micropower single-inductor, multiple-output (SIMO) buck-boost DC-to-DC converter designed for applications that emphasize low supply current and small solution size. A single inductor is used to regulate three separate outputs, saving board space while delivering better total system efficiency than equivalent power solutions using one buck and linear regulators.

The buck-boost configuration utilizes the entire battery voltage range due to its ability to create output voltages that are above, below, or equal to the input voltage. Peak inductor current for each output is programmable to optimize the balance between efficiency, output ripple, EMI, PCB design, and load capability.

To further boost efficiency when the output voltage is always lower than the input, individual channels of the SIMO buckboost converter can be configured to be in buck-only or boost-only mode, reducing switching losses by toggling less switches compared to buck-boost mode. See the <u>SIMO Buck Mode (MAX77643)</u> and <u>SIMO Boost Mode (MAX77643)</u> sections for more details.

#### **SIMO Features and Benefits**

- Three Output Channels
- Ideal for Low-Power Designs
  - Delivers up to 500mA at 1.8V from a 3.7V Input
  - ±2% Accurate Output Voltage
- Small Solution Size
  - Multiple Outputs from a Single 1.5µH Inductor
  - Small 10µF (0402) Output Capacitors
- Flexible and Easy to Use
  - Single Mode of Operation
  - · Glitchless Transitions Between Buck, Boost, and Buck-Boost Modes
  - Programmable Peak Inductor Current
  - Programmable On-Chip Active Discharge
  - Programmable Buck-Only and Boost-Only Mode (MAX77643)
  - Resistor Programmable Output Voltages (MAX77642)
- Long Battery Life
  - High Efficiency, > 91% at 1.8V Output
  - Better Total System Efficiency than Buck + LDOs
  - Low Quiescent Current, 1µA per Output
  - Low Input Operating Voltage, 2.7V (min)

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## **SIMO Detailed Block Diagram**

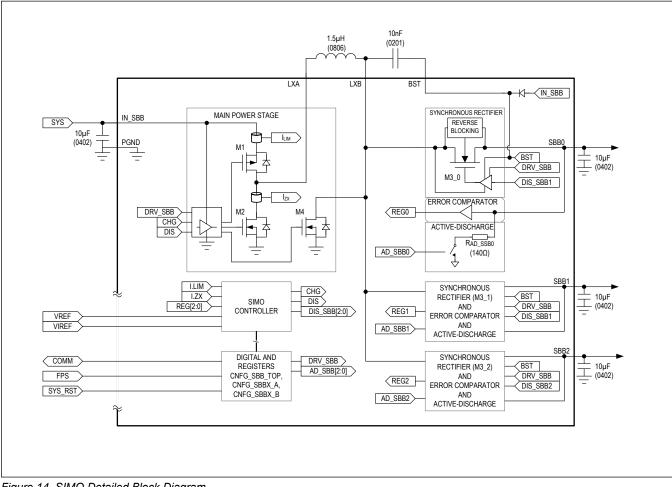


Figure 14. SIMO Detailed Block Diagram

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### **SIMO Control Scheme**

The SIMO buck-boost is designed to service multiple outputs simultaneously. A proprietary controller ensures that all outputs get serviced in a timely manner, even while multiple outputs are contending for the energy stored in the inductor. When no regulator needs service, the state machine rests in a low-power rest state.

When the controller determines that a regulator requires service, it charges the inductor (M1 + M4) until the peak current limit is reached ( $I_{LIM} = CNFG\_SBBx\_B.IP\_SBB[1:0]$ ). The inductor energy then discharges (M2 + M3\_x) into the output until the current reaches zero ( $I_{ZX}$ ). In the event that multiple output channels need servicing at the same time, the controller ensures that no output utilizes all of the switching cycles. Instead, cycles interleave between all the outputs that are demanding service, while outputs that do not need service are skipped.

#### Drive Strength (MAX77643)

The SIMO regulator's drive strength for its internal power MOSFETs is adjustable using the CNFG\_SBB\_TOP.DRV\_SBB[1:0] bit field. The ideal value is determined experimentally for each application. For a PCB layout comparable to the MAX77642/MAX77643 evaluation kit, 0x1 is the best setting and represents a balance between efficiency and EMI. Faster settings result in higher efficiency but generally require stricter layout rules or shielding to avoid additional EMI. Slower settings limit EMI in non-ideal settings (e.g., contained layout, antennae adjacent to the device, etc.). Change the drive strength only once during system initialization.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### SIMO Output Voltage Configuration

Each of the SIMO outputs are independently configurable. To set the output voltages at SBB0/1/2 for the MAX77642, connect the appropriate resistors from RSET\_SBB0/1/2 to GND as shown in <u>Table 8</u> and <u>Table 9</u>. The RSET\_SBB0/1/2 resistors should have 1% or better tolerance. To set the output voltages at SBB0/1/2 for the MAX77643, use the I<sup>2</sup>C interface to load the configuration registers CNFG\_SBBx\_A.TV\_SBBx[7:0]. This 8-bit configuration is a linear transfer function that starts at 0.5V and ends at 5.5V with 25mV increments, and sets the output voltage as: SBBx = 0.5V + 25mV x TV\_SBBx[7:0] (decimal).

## Table 8. SBB0 Output Voltage Settings

RSET_SBB0 (kΩ)	OUTPUT VOLTAGE - SBB0 (V)
0.001	0.50
4.99	0.60
6.00	0.70
7.15	0.80
8.45	0.90
10.0	1.00
11.8	1.05
14.0	1.10
16.9	1.20
20.0	1.30
23.7	1.40
28.0	1.60
34.0	1.75
40.2	1.80
47.5	1.85
56.2	2.00
66.5	2.20
80.6	2.40
95.76	2.80
113.0	3.00
133.0	3.20
162.0	3.25
191.0	3.30
226.0	3.35
267.0	3.40
324.0	3.80
383.0	4.00
452.0	4.20
536.0	4.40
634.0	4.60
768.0	5.00
909.0	5.20

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## Table 9. SBB1/2 Output Voltage Settings

RSET_SBB1/2 (kΩ)	OUTPUT VOLTAGE - SBB1/2 (V)
0.001	0.50
4.99	0.60
6.00	0.70
7.15	0.80
8.45	0.90
10.0	1.00
11.8	1.10
14.0	1.20
16.9	1.30
20.0	1.40
23.7	1.60
28.0	1.80
34.0	2.00
40.2	2.20
47.5	2.40
56.2	2.60
66.5	2.80
80.6	3.00
95.76	3.20
113.0	3.30
133.0	3.40
162.0	3.60
191.0	3.80
226.0	4.00
267.0	4.20
324.0	4.40
383.0	4.60
452.0	4.80
536.0	5.00
634.0	5.20
768.0	5.40
909.0	5.50

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### Peak Current Configuration

The peak inductor current limit corresponding to each SIMO output are independently configurable. To set the inductor peak current for the MAX77642, connect the appropriate resistors from RSET\_IPK to GND as shown in <u>Table 10</u>. The RSET\_IPK resistors should have a 1% or better tolerance. To set the inductor peak current for the MAX77643, use the I<sup>2</sup>C interface to load the configuration registers CNFG\_SBBx\_B.IP\_SBBx[5:4].

· · · · · · · · · · · · · · · · · · ·							
RSET_IPK (kΩ)	SBB_PK2 (A)	SBB_PK1 (A)	SBB_PK0 (A)				
Short	0.5	0.5	0.5				
4.99	0.5	0.5	1.0				
6.00	0.5	1.0	0.5				
7.15	1.0	0.5	0.5				
8.45	1.0	1.0	0.5				
10.0	1.0	0.5	1.0				
11.8	0.5	1.0	1.0				
14.0	1.0	1.0	1.0				

## **Table 10. Inductor Peak Current Setting**

### SIMO Soft-Start

The soft-start feature of the SIMO limits inrush current during startup. The soft-start feature is achieved by limiting the slew rate of the output voltage during startup (dV/dt<sub>SS</sub>).

More output capacitance results in higher input current surges during startup. The following equations and example describe the input current surge phenomenon during startup.

In buck-boost mode, the current into the output capacitor (I<sub>CSBB</sub>) during soft-start is:

$$I_{\text{CSBB}} = C_{\text{SBB}} \times \frac{dV}{dt_{\text{SS}}} \left( \text{Equation 1} \right)$$

where:

- C<sub>SBB</sub> is the capacitance on the output of the regulator
- dV/dt<sub>SS</sub> is the voltage change rate of the output

The input current (I<sub>IN</sub>) during soft-start is:

$$I_{\rm IN} = \frac{\left(I_{\rm CSBB} + I_{\rm LOAD}\right) \frac{V_{\rm SBBx}}{V_{\rm IN}}}{\xi} \left( \text{Equation } 2 \right)$$

where:

- I<sub>CSBB</sub> is calculated using Equation 1
- I<sub>LOAD</sub> is current consumed from the external load
- V<sub>SBBx</sub> is the output voltage
- V<sub>IN</sub> is the input voltage
- $\xi$  is the efficiency of the regulator

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For example, given the following conditions, the peak input current (I<sub>IN</sub>) during soft-start is ~71mA:

Given:

- V<sub>IN</sub> is 3.5V
- V<sub>SBB2</sub> is 3.3V
- C<sub>SBB2</sub> = 10µF
- dV/dt<sub>SS</sub> = 5mV/µs
- R<sub>LOAD2</sub> = 330Ω (I<sub>LOAD2</sub> = 3.3V/330Ω = 10mA)
- ξ is 80%

Calculation:

- I<sub>CSBB</sub> = 10µF x 5mV/µs (from Equation 1)
- I<sub>CSBB</sub> = 50mA
- $I_{\text{IN}} = \frac{(50\text{mA} + 10\text{mA})\frac{3.3V}{3.5V}}{0.85}$  (from Equation 1)
- I<sub>IN</sub> ~ 71mA

### SIMO Registers (MAX77643)

Each SIMO buck-boost channel has a dedicated register to program its target output voltage (CNFG SBBx A.TV SBBx[7:0]) and its peak current limit (CNFG SBBx B.IP SBBx[1:0]). Additional controls are available for enabling/disabling the active-discharge resistors (CNFG\_SBBx\_B.ADE\_SBBx), buck-only, boost-only, buckboost only, and automatic mode (CNFG SBBx B.OP MODE) as well as enabling/disabling the SIMO buck-boost channels (CNFG SBBx B.EN SBBx[2:0]). For a full description of bits, registers, default values, and reset conditions, see the Register Map.

### SIMO Active Discharge Resistance

Each SIMO buck-boost channel has an active-discharge resistor (RAD SBBx) that is automatically enabled/disabled based on a CNFG\_SBBx\_B.ADE\_SBBx bit and the status of the SIMO regulator. The active discharge feature may be enabled (CNFG SBBx B.ADE SBBx = 1) or disabled (CNFG SBBx B.ADE SBBx = 0) independently for each SIMO channel. Enabling the active discharge feature helps ensure a complete and timely power down of all system peripherals. If the active-discharge resistor is enabled by default, then the active-discharge resistor is on whenever V<sub>SYSA</sub> is below VSYSAUVLO and above VPOR.

These resistors discharge the output when CNFG\_SBBx\_B.ADE\_SBBx = 1, and their respective SIMO channel is off. If the regulator is forced on through CNFG SBBx B.EN SBBx[2:0] = 0b110 or 0b111, then the resistors do not discharge the output even if the regulator is disabled by the main-bias.

Note that when V<sub>SYSA</sub> is less than 1.0V, the NMOS transistors that control the active-discharge resistors lose their gate drive and become open.

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### SIMO Buck Mode (MAX77643)

If the input voltage at IN\_SBB never falls below the output voltage of one or more SIMO converter channels, individual channels can be configured to be in buck mode with the CNFG\_SBBx\_B.OP\_MODE bit. In buck mode, when an output needs service, switch M3\_x remains closed and M4 remains open (see <u>Figure 14</u>). Only M1 and M2 are toggled as in a traditional buck converter. Efficiency is boosted due to three major factors:

- Reduced switching loss: Buck mode toggles only two switches versus the four in buck-boost mode. Therefore, there are less switching events during which power is consumed.
- Lower inductor core losses: Inductor current changes from 0A to peak current. The larger the change in current the inductor experiences, the more energy is lost in the inductor core in the form of heat. In buck mode, the peak current can be reduced since less inductor current is needed to support a load. Less inductor current is needed because of direct energy transfer. Direct energy transfer occurs while the inductor is charged, when the input (IN\_SBB) is connected directly to the output (SBBx) through the inductor. Therefore, the input not only provides energy to charge the inductor, energy is also supplied to the output capacitor and load devices. Therefore, less current is needed to charge the inductor, which is used to charge the output capacitor in the next switching state.
- Less frequent charging cycles: In buck-boost mode, the output capacitor is charged only while the inductor is being discharged. Again because of direct energy transfer, the output capacitor is charged during both the inductor charge and discharge times. In addition, with the same peak current limit, the inductor charge time is longer with buck mode. Therefore, the output capacitor can support the output voltage longer before needing to be recharged.

Maintain a minimum headroom of 0.7V between IN\_SBB and SBBx in buck mode because inductor charge time (dt =  $L \times I_{P\_SBBx}/(V_{IN\_SBB} - V_{SBBx})$ ) increases as the difference between the IN\_SBB and SBBx voltages shrinks. As the inductor current takes longer to reach its peak, the output voltage might take too long to reach its target voltage, and the MAX77643 might trigger a fault flag.

### SIMO Boost Mode (MAX77643)

If the input voltage at IN\_SBB never rises above the output voltage of one or more SIMO converter channels, individual channels can be configured to be in boost mode with the CNFG\_SBBx\_B.OP\_MODE bit. In boost mode, when an output needs service, switch M1 remains closed and M2 remains open (see Figure 14). Only M3x and M4 are toggled as in a traditional boost converter. Efficiency is boosted due to three major factors:

- Reduced switching loss: Boost mode toggles only two switches versus the four in buck-boost mode. Therefore, there are less switching events during which power is consumed.
- Lower inductor core losses: Inductor current changes from 0A to peak current. The larger the change in current the inductor experiences, the more energy is lost in the inductor core in the form of heat. In boost mode, the peak current can be reduced since less inductor current is needed to support a load. Less inductor current is needed because of direct energy transfer. Direct energy transfer occurs while the inductor is discharged, when the input (IN\_SBB) is connected directly to the output (SBBx) through the inductor. Therefore, the input not only provides energy to charge the inductor, energy is also supplied to the output capacitor and load devices. Therefore, less current is needed to charge the inductor, which is used to charge the output capacitor in the next switching state.
- Less frequent charging cycles: The inductor discharge time is longer with boost mode. Therefore, the output capacitor can support the output voltage longer before needing to be recharged.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### **Applications Information**

#### SIMO Available Output Current

The available output current on a given SIMO channel is a function of the input voltage, output voltage, the peak current limit setting, and the output current of the other SIMO channels. Maxim offers a calculator found in the design resources tab of the MAX77642/MAX77643's webpage that outlines the available capacity for specific conditions. <u>Table 11</u> is an extraction from the calculator.

## **Table 11. SIMO Available Output Current for Common Applications**

PARAMETERS	EXAMPLE 1	EXAMPLE 2	EXAMPLE 3	EXAMPLE 4	EXAMPLE 5	
V <sub>IN_MIN</sub>	2.7V	2.7V	3.2V	3.4V	3.6V	
R <sub>L_DCR</sub>	0.1Ω	0.1Ω	0.1Ω	0.12Ω	0.12Ω	
SBB0	1.0V at 100mA	1.0V at 80mA	1.2V at 50mA	1.2V at 20mA	1.2V at 20mA	
SBB1	1.2V at 75mA	1.2V at 50mA	2.05V at 100mA	2.05V at 80mA	2.05V at 80mA	
SBB2	1.8V at 50mA	1.8V at 40mA	3.3V at 30mA	3.3V at 10mA	2.05V at 5mA	
Operating Mode	Buck-Boost	Buck	Buck-Boost	Buck-Boost	Buck	
I <sub>P_SBB0</sub>	1A	1A	1A	0.5A	1A	
IP_SBB1	1A	1A	0.75A	0.5A	1A	
IP_SBB2	1A	1A	1A	0.5A	0.5A	
Utilized Capacity	73%	77%	79%	73%	79%	

 $*ESR_{C_{IN}} = ESR_{C_{OUT}} = 5m\Omega, L = 1.5\mu H$ 

#### **Inductor Selection**

Choose an inductance from  $1.0\mu$ H to  $2.2\mu$ H;  $1.5\mu$ H inductors work best for most designs. Larger inductances transfer more energy to the output for each cycle and typically result in larger output voltage ripple and better efficiency. See the <u>Output Capacitor Selection</u> section for more information on how to size your output capacitor in order to control ripple.

Choose the inductor saturation current to be greater than or equal to the maximum peak current limit setting that is used for all of the SIMO buck-boost channels ( $I_{P\_SBBx}$ ). For example, if SBB0 is set for 0.5A, SBB1 is set for 0.75A, and SBB2 is set for 1.0A, then choose the saturation current to be greater than or equal to 1.0A.

Choose the RMS current rating of the inductor (typically the current at which the temperature rises appreciably) based on the expected load currents for the system. For systems where the expected load currents are not well known, be conservative and choose the RMS current to be greater than or equal to half the higher maximum peak current limit setting [ $I_{RMS} \ge MAX$  ( $I_{P\_SBB0}$ ,  $I_{P\_SBB1}$ ,  $I_{P\_SB2}$ ) / 2]. This is a conservative choice because the SIMO buck-boost regulator implements a discontinuous conduction mode (DCM) control scheme, which returns the inductor current to zero each cycle.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

Consider the DC-resistance (DCR), AC-resistance (ACR), and solution size of the inductor. Typically, smaller sized inductors have larger DC-resistance and larger AC-resistance that reduces efficiency and the available output current. Note that many inductor manufacturers have inductor families which contain different versions of core material in order to balance trade-offs between DCR, ACR (i.e., core losses), and component cost. For this SIMO regulator, inductors with the lowest ACR in the 1.0MHz to 2.0MHz region tend to provide the best efficiency.

#### **Input Capacitor Selection**

Choose the input bypass capacitance ( $C_{IN\_SBB}$ ) to be 10µF. Larger values of  $C_{IN\_SBB}$  improve the decoupling for the SIMO regulator.

The C<sub>IN\_SBB</sub> reduces the current peaks drawn from the battery or input power source during SIMO regulator operation and reduces switching noise in the system. The ESR/ESL of the input capacitor should be very low (i.e., ESR  $\leq$  5m $\Omega$  and ESL  $\leq$  500pH) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

To fully utilize the available input voltage range of the SIMO (5.5V, max), use a capacitor with a voltage rating of 6.3V at minimum.

#### **Boost Capacitor Selection**

Choose the boost capacitance ( $C_{BST}$ ) to be 10nF. Smaller values of  $C_{BST}$  (< 1nF) result in insufficient gate drive for M3. Larger values of  $C_{BST}$  (> 10nF) have the potential to degrade the startup performance. Ceramic capacitors with 0201 or 0402 case size are recommended.

#### **Output Capacitor Selection**

Choose each output bypass capacitance ( $C_{SBBx}$ ) based on the target output voltage ripple ( $\Delta V_{SBBx}$ ). Typical values are 22µF. Larger values of  $C_{SBBx}$  improve the output voltage ripple but increase the input surge currents during soft-start and output voltage changes. The output voltage ripple is a function of the inductance (L), the output voltage ( $V_{SBBx}$ ), and the peak current limit setting ( $I_{P}$  SBBx). See Equation 3 to estimate required, effective capacitance.

$$C_{\text{SBBx}} = \frac{V_{\text{P}} \text{SBBx}^2 \times L}{2 \times V_{\text{SBBx}} \times \Delta V_{\text{SBBx}}(\text{Equation 3})}$$

Maxim also offers a calculator to aid in the selection of the output capacitance found in the design resources tab of the MAX77642/MAX77643 product page. Note that most designs concern themselves with having enough capacitance on the output but there is also a maximum capacitance limitation that is calculated within the SIMO calculator; take care not to exceed the maximum capacitance.

The  $C_{SBBx}$  is required to keep the output voltage ripple small. The impedance of the output capacitor (ESR, ESL) should be very low (i.e., ESR  $\leq 5m\Omega$  and ESL  $\leq 500$ pH) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

A capacitor's effective capacitance decreases with increased DC bias voltage. This effect is more pronounced as capacitor case sizes decrease. Due to this characteristic, it is possible for an 0603 case size capacitor to perform well, while an 0402 case size capacitor of the same value performs poorly. The SIMO regulator is stable with low output capacitance ( $1\mu$ F) but the output voltage ripple would be large; consider the effective output capacitance value after initial tolerance, bias voltage, aging, and temperature derating.

#### SIMO Switching Frequency

The SIMO buck-boost regulator uses a pulse frequency modulation (PFM) control scheme. The switching frequency for each output is a function of the operating mode, input voltage, output voltage, load current, and inductance. Output capacitance is a minor factor in SIMO switching frequency. Maxim offers a SIMO calculator found in the design resources tab of the MAX77642/MAX77643 product page to estimate expected switching frequency.

<u>Table 12</u> lists how different factors increase or decrease switching frequency.

## Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

FACTOR	INCREASING FREQUENCY	DECREASING FREQUENCY		
Inductor Current Peak Limit	Lower peak limit	Higher peak limit		
Operating Mode	Buck-boost mode Buck mode or boost mode			
Inductor	Decrease inductance	Increase inductance		
Output Capacitor	Decrease capacitance	Increase capacitance		
Input Voltage	Higher voltage	Lower voltage		
Output Voltage	Higher voltage	Lower voltage		
Load Current	Higher current	Lower current		

### **Table 12. Switching Frequency Control**

#### **Unused Outputs**

Do not leave unused outputs unconnected. If an output left unconnected is accidentally enabled, the charged inductor experiences an open circuit, and the output voltage soars above the absolute maximum rating, damaging the device. If an output is not used, do one of the following:

- 1. Disable the output (CNFG\_SBBx\_B.EN\_SBBx[2:0] = 0x4 or 0x5) and connect the output to ground. If an unused output is default enabled or can be accidentally enabled, do one of the other recommendations instead.
- 2. Bypass the unused output with a  $1\mu$ F capacitor to ground.
- Connect the unused output to IN\_SBB or a different output channel if the unused output is programmed to a lower voltage. Since the output voltage is higher than the unused output, the regulator does not service the unused output even if it is unintentionally enabled.
  - Note that some OTP options have the active-discharge resistors enabled by default. Connecting an unused output
    to IN\_SBB is not recommended if the active discharge is enabled by default. If connecting the unused output to a
    different channel, disable the active-discharge resistor (CNFG\_SBBx\_B.ADE\_SBBx = 0) of the unused channel.

#### **PCB Layout Guide**

#### Capacitors

Place decoupling capacitors as close as possible to the IC such that connections from capacitor pads to pin and from capacitor pads to ground pins are short. Keeping the connections short lowers parasitic inductance and resistance, improving performance and shrinking the physical size of hot loops.

If connections to the capacitors are through vias, use multiple vias to minimize parasitics. Also, connect loads to the capacitor pads rather than the device pins.

Most critical are the capacitors for the switching regulator: input capacitor at IN\_SBB and output capacitors at SBBx.

#### Input Capacitor at IN\_SBB

Minimize the parasitic inductance from PGND to input capacitor to IN\_SBB to reduce ringing on the LXA voltage.

#### Output Capacitors at SBBx

The output capacitors experience large changes in current as the regulator charges (buck mode) and discharges (both modes) the inductor. In buck mode, the capacitor current ramps up at the same rate as mentioned in the <u>Input Capacitor</u> <u>at IN\_SBB</u> section. In buck-boost mode, the capacitor current ramps up very quickly. In both modes, the capacitor current

ramps down at a rate of  $\frac{dI_{C}SBBx}{dt} = \frac{V_{SBBx}}{L}$  from inductor peak current. Since the ramp down can occur in less than the current increases rapidly for buck-boost mode, minimize parasitic inductance from SBBx to output capacitor.

1µs, and the current increases rapidly for buck-boost mode, minimize parasitic inductance from SBBx to output capacitor to PGND.

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#### Inductor

Keep the inductor close to the IC to reduce trace resistance; however, prioritize any regulator input/output capacitors over the inductor. Use the appropriate trace width from LXA to inductor to LXB to support the peak inductor current. Likewise, if there are vias in the path, use an appropriate amount of vias to support the peak current.

#### **Ground Connections**

As the switching regulator charges and discharges the inductor, current flows from PGND to the input capacitor ground, from output capacitor ground to PGND, or from output capacitor ground to input capacitor ground. Therefore, use a wide, continuous copper plane to connect PGND to the capacitor grounds.

When connecting the GND and PGND pins together, ensure noise from the power ground does not enter the analog ground (where GND is connected). For example, assuming the ground pins are connected through a solid ground plane on an internal layer, one via connecting GND to the internal ground plane may be sufficient to protect GND from most of the noise in the power-ground plane. Likewise, if there are other higher current or noisy circuitry near this device, avoid connecting the GND pin directly to their grounds.

For more guidelines on proper grounding, visit: <u>https://www.maximintegrated.com/en/design/partners-and-technology/</u> design-technology/ground-layout-board-designers.html.

#### **Example PCB Layout**

Figure 15 shows an example layout of the top layer.

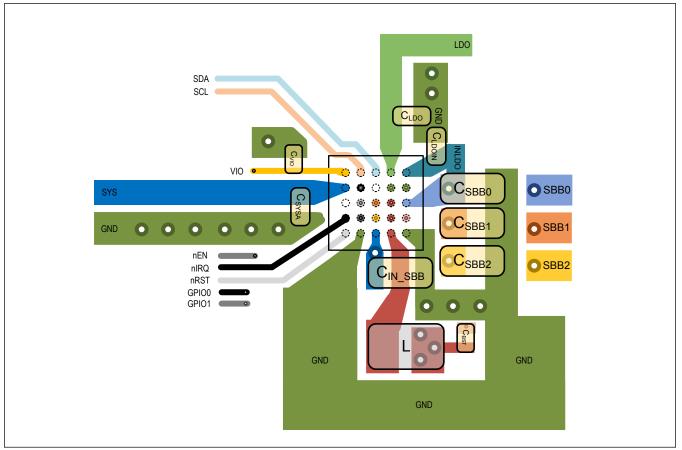


Figure 15. PCB Top-Layer and Component Placement Example

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## Detailed Description—Low Dropout Linear Regulator (LDO)/Load Switch (LSW)

The device includes an on-chip low-dropout linear regulator (LDO0) that can also be configured as load switches. The LDO is optimized to have low-quiescent current. The input voltage range ( $V_{IN\_LDO}$ ) allows it to be powered directly from the main energy source such as a Li-Poly battery or from an intermediate regulator. The linear regulator delivers up to 150mA.

### **Features and Benefits**

- 1x 150mA LDO
- LDO Input Voltage Range: 1.71V to 5.5V
- LSW Input Voltage Range: 1.20V to 5.5V
- Resistor Adjustable Output Voltage (MAX77642)
- I<sup>2</sup>C Adjustable Output Voltage (MAX77643)
- 100mV Maximum Dropout Voltage at ECT Conditions
- Programmable On-Chip Active Discharge

### LDO/LSW Simplified Block Diagram

The LDO/LSW block has one input (IN\_LDO) and one output (LDO) and several ports that exchange information with the rest of the device ( $V_{REF}$ , EN\_LDO, ADE\_LDO). The  $V_{REF}$  comes from the main bias circuits. The CNFG\_LDO0\_B.EN\_LDO and CNFG\_LDO0\_B.ADE\_LDO are register bits for controlling the enable and active-discharge feature, respectively. See the *Register Map* for more information.

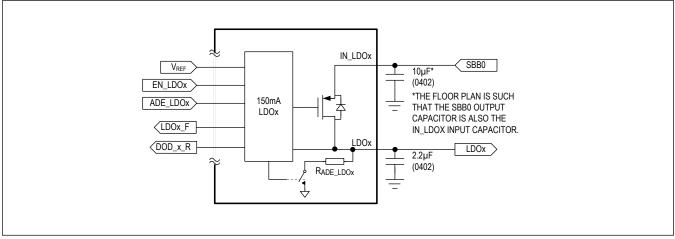


Figure 16. LDO Simplified Block Diagram

### LDO Output Voltage Configuration

To set the output voltages for the on-chip LDO for the MAX77642, connect the appropriate resistor from RSET\_LDO to GND as shown in [[LDO OUTPUT VOLTAGE SETTING]]. RSET\_LDO resistor should have 1% or better tolerance. To set the output voltages for the on-chip LDO for the MAX77643, use the I<sup>2</sup>C interface to load the configuration register TV\_LDO[7:0]. TV\_LDO[7] is used to enable (TV\_LDO[7] = 1) or disabled (TV\_LDO[7] = 0) a 1.325mV offset to the LDO's output voltage. The bits TV\_LDO[6:0] are used to set the output voltage as:

LDO = 0.5V + TV\_LDO[7] + (25mV x TV\_LDO[6:0] (decimal))

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## Table 13. LDO Output Voltage Setting

RSET_LDO (kΩ)	LDO OUTPUT VOLTAGE (V)			
Short	0.50			
4.99	0.60			
6.00	0.70			
7.15	0.80			
8.45	0.90			
10.0	0.95			
11.8	1.00			
14.0	1.05			
16.9	1.10			
20.0	1.15			
23.7	1.20			
28.0	1.25			
34.0	1.30			
40.2	1.40			
47.5	1.50			
56.2	1.60			
66.5	1.70			
80.6	1.80			
95.76	1.90			
113.0	2.00			
133.0	2.10			
162.0	2.20			
191.0	2.40			
226.0	2.50			
267.0	2.60			
324.0	2.80			
383.0	3.00			
452.0	3.20			
536.0	3.40			
634.0	3.60			
768.0	3.80			
909.0	4.00			

### LDO/LSW Active-Discharge Resistor

The LDO/LSW block has an active-discharge resistor ( $R_{AD\_LDO}$ ) that is enabled if CNFG\_LDO0\_B.ADE\_LDO = 1 and LDO is disabled. Enabling the active discharge feature helps ensure a complete and timely power down of the resource. During power up, if  $V_{SYSA} > V_{POR}$  and CNFG\_LDO\_B.ADE\_LDO = 1, the active-discharge resistor is enabled.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### LDO/LSW Soft-Start

The soft-start feature limits inrush current during startup, and is achieved by limiting the slew rate of the output voltage during startup ( $dV_{OUT\_LDO}/dt_{SS}$ ).

More output capacitance results in higher input current surges during startup. The following equation and example describe the input current surge phenomenon during startup.

The input current (I<sub>IN LDO</sub>) during soft-start is calculated as:

$$I_{\text{IN}\_\text{LDOx}} = C_{\text{LDOx}} \frac{dV_{\text{OUT}\_\text{LDOx}}}{dt_{\text{SS}}} + I_{\text{OUT}\_\text{LDOx}}$$

where:

- C<sub>LDO</sub> is the capacitance on the output of the regulator
- dV<sub>OUT LDO</sub>/dt<sub>SS</sub> is the voltage change rate of the output

For example, given the following conditions, the input current (I<sub>IN LDO</sub>) during soft-start is 13.08mA:

Given:

- C<sub>LDO</sub> = 2.2µF
- dV<sub>OUT LDO</sub>/dt<sub>SS</sub> = 2.2mV/µs
- LDO programmed to 1.85V
- $R_{LDO} = 185\Omega (I_{OUT\_LDO} = 1.85V/185\Omega = 10mA)$

Calculation:

- I<sub>IN</sub> = 2.2µF x 2.2mV/µs + 10mA
- I<sub>IN</sub> = 14.84mA

### Load Switch Configuration

The LDO0 can be configured as load switches with the CNFG\_LDO0\_B.LDO\_MD bit. As shown in <u>Figure 17</u>, the transition from LDO to LSW mode is controlled by a defined slew rate until dropout is detected. Once dropout is detected, the load switch is fully closed and the dropout interrupt flag (INT\_GLBL.DOD\_R) is set.

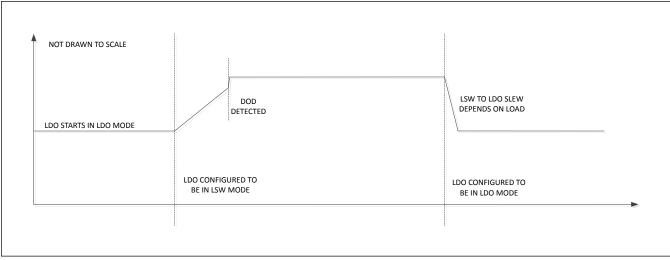


Figure 17. LDO to LSW Transition Waveform

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### **Applications Information**

#### **Input Capacitor Selection**

Make sure the input bypass capacitance ( $C_{IN\_LDO}$ ) is at least 2.2µF. Larger values of  $C_{IN\_LDO}$  improve the decoupling for LDO. The floor plan of the device is such that SBB0 is adjacent to IN\_LDO and if the SIMO channel 0 output powers the input of LDO, then its output capacitor ( $C_{SBB0}$ ) can also serve as  $C_{IN\_LDO}$  such that only one capacitor is required.

The C<sub>IN\_LDO</sub> reduces the current peaks drawn from the battery or input power source during operation. The impedance of the input capacitor (ESR, ESL) should be very low (i.e., ESR  $\leq 50$ m $\Omega$  and ESL  $\leq 5$ nH) for frequencies up to 0.5MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

#### **Output Capacitor Selection**

For both LDO and LSW modes, choose the output bypass capacitance (C<sub>LDO</sub>) to be 1µF.

In LDO mode, larger values of  $C_{LDO}$  improve output PSRR but increase input surge currents during soft-start and output voltage changes. The effective output capacitance should not exceed 2.8µF to maintain stability.

While in LDO mode,  $C_{LDO}$  is required to keep stability. The series inductance of the output capacitor and its series resistance should be low (i.e., ESR  $\leq 10m\Omega$  and ESL  $\leq 1nH$ ) for frequencies up to 0.5MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

A capacitor's effective capacitance decreases with increased DC bias voltage. This effect is more pronounced with smaller capacitor case sizes. Due to this characteristic, 0603 case size capacitors tend to perform well while 0402 case size capacitors of the same value perform poorly.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## Detailed Description—I<sup>2</sup>C Serial Communication

### **General Description**

The IC features a revision 3.0 I<sup>2</sup>C-compatible, 2-wire serial interface consisting of a bidirectional serial data line (SDA) and a serial clock line (SCL). This device acts as a slave-only device, relying on the master to generate a clock signal. SCL clock rates from 0Hz to 3.4MHz are supported.

The I<sup>2</sup>C is an open-drain bus and therefore SDA and SCL require pullups. Optional resistors (24 $\Omega$ ) in series with SDA and SCL protect the device inputs from high-voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus signals.

<u>Figure 18</u> shows the functional diagram for the l<sup>2</sup>C-based communications controller. For additional information on l<sup>2</sup>C, refer to the  $l^2C$  Bus Specification and User Manual which is available for free through the internet.

#### Features

- I<sup>2</sup>C Revision 3.0 Compatible Serial Communications Channel
- 0Hz to 100kHz (Standard Mode)
- 0Hz to 400kHz (Fast Mode)
- 0Hz to 1MHz (Fast-Mode Plus)
- 0Hz to 3.4MHz (High-Speed Mode)
- Does not utilize I<sup>2</sup>C Clock Stretching

### I<sup>2</sup>C Simplified Block Diagram

There are three pins (aside from GND) for the  $I^2C$ -compatible interface. The  $V_{IO}$  determines the logic level, SCL is the clock line, and SDA is the data line. Note that the interface does **not** have the ability to drive the SCL line.

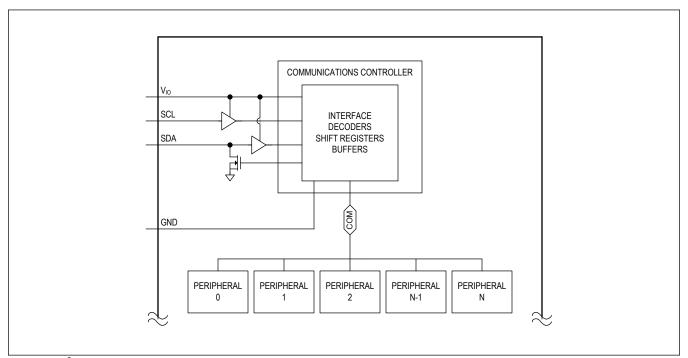


Figure 18. I<sup>2</sup>C Simplified Block Diagram

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## I<sup>2</sup>C System Configuration

The I<sup>2</sup>C-compatible interface is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.

A device on the I<sup>2</sup>C bus that sends data to the bus is called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates the SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. The I<sup>2</sup>C-compatible interface operates as a slave on the I<sup>2</sup>C bus with transmit and receive capabilities.

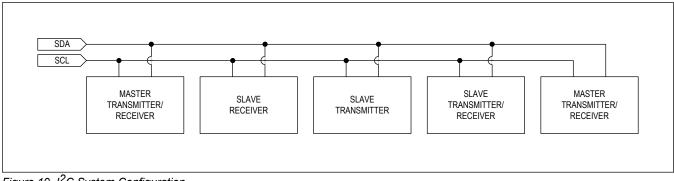


Figure 19. I<sup>2</sup>C System Configuration

### I<sup>2</sup>C Interface Power

The I<sup>2</sup>C interface derives its power from V<sub>IO</sub>. Typically a power input such as V<sub>IO</sub> would require a local 0.1µF ceramic bypass capacitor to ground. However, in highly integrated power distribution systems, a dedicated capacitor might not be necessary. If the impedance between V<sub>IO</sub> and the next closest capacitor ( $\ge 0.1 \mu F$ ) is less than 100m $\Omega$  in series with 10nH, then a local capacitor is not needed. Otherwise, bypass  $V_{IO}$  to GND with a 0.1µF ceramic capacitor.

The V<sub>IO</sub> accepts voltages from 1.7V to 3.6V (V<sub>IO</sub>). Cycling V<sub>IO</sub> does not reset the I<sup>2</sup>C registers. When V<sub>IO</sub> is less than VIOUVLO and VSYSA is less than VSYSAUVLO, SDA and SCL are high impedance.

## I<sup>2</sup>C Data Transfer

One data bit is transferred during each SCL clock cycle. The data on SDA must remain stable during the high period of the SCL clock pulse. Changes in SDA while SCL is high are control signals. See the I<sup>2</sup>C Start and Stop Conditions section. Each transmit sequence is framed by a START (S) condition and a STOP (P) condition. Each data packet is 9 bits long: 8 bits of data followed by the acknowledge bit. Data is transferred with the MSB first.

## I<sup>2</sup>C Start and Stop Conditions

When the serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high. See Figure 20.

A START condition from the master signals the beginning of a transmission to the device. The master terminates transmission by issuing a not-acknowledge followed by a STOP condition (see the I2C Acknowledge Bit section for information on not-acknowledge). The STOP condition frees the bus. To issue a series of commands to the slave, the master can issue repeated start (Sr) commands instead of a STOP command to maintain control of the bus. In general a repeated start command is functionally equivalent to a regular start command.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

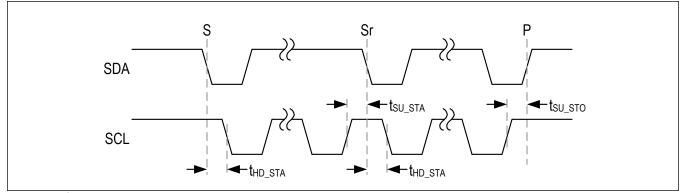


Figure 20. I<sup>2</sup>C Start and Stop Conditions

### I<sup>2</sup>C Acknowledge Bit

Both the I<sup>2</sup>C bus master and slave devices generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each 9-bit data packet. To generate an acknowledge (A), the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. See <u>Figure 21</u>. To generate a not-acknowledge (nA), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.

Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

This device issues an ACK for all register addresses in the possible address space even if the particular register does not exist.

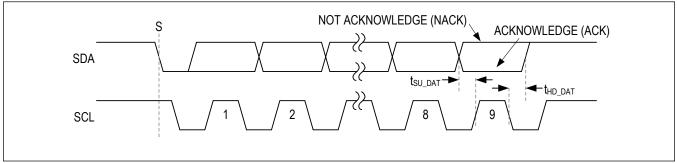


Figure 21. Acknowledge Bit

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## I<sup>2</sup>C Slave Address

The I<sup>2</sup>C controller implements 7-bit slave addressing. An I<sup>2</sup>C bus master initiates communication with the slave by issuing a START condition followed by the slave address. See <u>Figure 22</u>. The OTP address is factory-programmable for one of two options. See <u>Table 14</u>. All slave addresses not mentioned in <u>Table 14</u> are not acknowledged.

	-		
ADDRESS	7-BIT SLAVE ADDRESS	8-BIT WRITE ADDRESS	8-BIT READ ADDRESS
Main Address (ADDR = 0)*	0x40, 0b 100 0000	0x80, 0b 1000 0000	0x81, 0b 1000 0001
Main Address (ADDR = 1)*	0x48, 0b 100 1000	0x90, 0b 1001 0000	0x91, 0b 1001 0001
Main Address (ADDR = 2)*	0x44, 0b 100 0100	0x88, 0b 1000 1000	0x89, 0b 1000 1001
Main Address (ADDR = 3)*	0x4C, 0b 100 1100	0x98, 0b 1001 1000	0x99, 0b 1001 1001
Test Mode**	0x49, 0b 100 1001	0x92, 0b 1001 0010	0x93, 0b 1001 0011

## Table 14. I<sup>2</sup>C Slave Address Options

\*Perform all reads and writes on the main address. The ADDR is a factory one-time programmable (OTP) option, allowing for address changes in the event of a bus conflict.

\*\*When test mode is unlocked, the additional address is acknowledged. Test mode details are confidential. If possible, leave the test mode address unallocated to allow for the rare event that debugging needs to be performed in cooperation with Maxim.

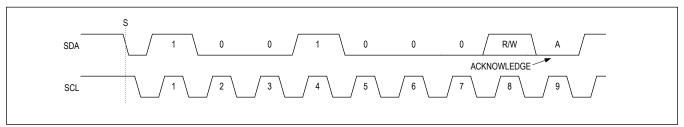


Figure 22. Slave Address Example

## I<sup>2</sup>C Clock Stretching

In general, the clock signal generation for the I<sup>2</sup>C bus is the responsibility of the master device. The I<sup>2</sup>C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The IC does not use any form of clock stretching to hold down the clock line.

## I<sup>2</sup>C General Call Address

This device does not implement the I<sup>2</sup>C specifications general call address and does not acknowledge the general call address (0b0000\_0000).

## I<sup>2</sup>C Device ID

This device does not support the I<sup>2</sup>C Device ID feature.

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

## I<sup>2</sup>C Communication Speed

This device is compatible with all four communication speed ranges as defined by the revision 3.0 I<sup>2</sup>C specification:

- 0Hz to 100kHz (Standard Mode)
- 0Hz to 400kHz (Fast Mode)
- 0Hz to 1MHz (Fast-Mode Plus)
- 0Hz to 3.4MHz (High-Speed Mode)

Operating in standard mode, fast mode, and fast-mode plus does not require any special protocols. The main consideration when changing bus speed through this range is the combination of the bus capacitance and pullup resistors. Larger values of bus capacitance and pullup resistance increase the time constant (C x R), slowing bus operation. Therefore, when increasing bus speeds, the pullup resistance must be decreased to maintain a reasonable time constant. Refer to the *Pullup Resistor Sizing* section of the I<sup>2</sup>C bus specification and user manual (available for free on the internet) for detailed guidance on the pullup resistor selection. In general for bus capacitances of 200pF, a 100kHz bus needs 5.6k $\Omega$  pullup resistors, a 400kHz bus needs about 1.5k $\Omega$  pullup resistors, and a 1MHz bus needs 680 $\Omega$  pullup resistors. Remember that, while the open-drain bus is low, the pullup resistor is dissipating power, and lower value pullup resistors dissipate more power (V<sup>2</sup>/R).

Operating in high-speed mode requires some special considerations. For a full list of considerations, refer to the publicly available I<sup>2</sup>C bus specification and user manual. Major considerations with respect to this part are:

- The I<sup>2</sup>C bus master uses current source pullups to shorten the signal rise.
- The I<sup>2</sup>C slave must use a different set of input filters on its SDA and SCL lines to accommodate for the higher bus.
- The communication protocols need to utilize the high-speed master code.

At power-up and after each stop condition, the bus input filters are set for standard mode, fast mode, and fast-mode plus (i.e., 0Hz to 1MHz). To switch the input filters for high-speed mode, use the high-speed master code protocols that are described in the  $l^2C$  Communication Protocols section.

## I<sup>2</sup>C Communication Protocols

Both writing to and reading from registers are supported as described in the following subsections.

#### Writing to a Single Register

Figure 23 shows the protocol for the I<sup>2</sup>C master device to write one byte of data to this device. This protocol is the same as the SMBus specification's write byte protocol.

The write byte protocol is as follows:

- 1. The master sends a start command (S).
- 2. The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4. The master sends an 8-bit register pointer.
- 5. The slave acknowledges the register pointer.
- 6. The master sends a data byte.
- 7. The slave updates with the new data.
- 8. The slave asserts an acknowledge or not acknowledge for the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
- 9. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

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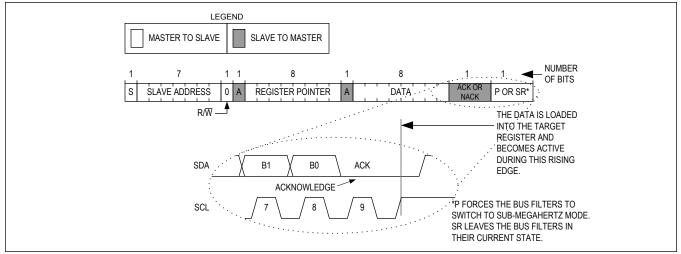


Figure 23. Writing to a Single Register with the Write Byte Protocol

#### Writing Multiple Bytes to Sequential Registers

Figure 24 shows the protocol for writing to sequential registers. This protocol is similar to the write byte protocol in the *Writing to a Single Register* section, except the master continues to write after it receives the first byte of data. When the master is done writing, it issues a stop or repeated start.

The write to sequential registers protocol is as follows:

- 1. The master sends a start command (S).
- 2. The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4. The master sends an 8-bit register pointer.
- 5. The slave acknowledges the register pointer.
- 6. The master sends a data byte.
- 7. The slave acknowledges the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
- 8. Steps 6 to 7 are repeated as many times as the master requires.
- 9. During the last acknowledge related clock pulse, the master can issue an acknowledge or a not acknowledge.
- 10. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

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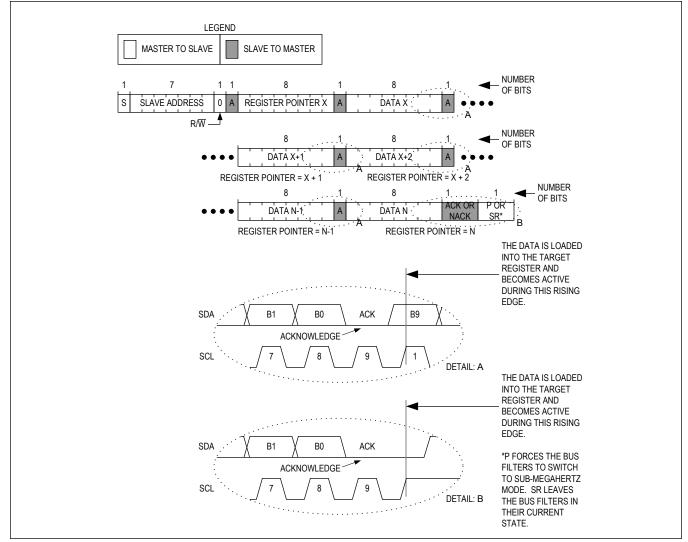


Figure 24. Writing to Sequential Registers X to N

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#### Reading from a Single Register

Figure 25 shows the protocol for the I<sup>2</sup>C master device to read one byte of data. This protocol is the same as the SMBus specification's read byte protocol.

The read byte protocol is as follows:

- 1. The master sends a start command (S).
- 2. The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4. The master sends an 8-bit register pointer.
- 5. The slave acknowledges the register pointer.
- 6. The master sends a repeated start command (Sr).
- 7. The master sends the 7-bit slave address followed by a read bit (R/W = 1).
- 8. The addressed slave asserts an acknowledge by pulling SDA low.
- 9. The addressed slave places 8-bits of data on the bus from the location specified by the register pointer.
- 10. The master issues a not acknowledge (nA).
- 11. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when this device receives a stop, the register pointer is not modified. Therefore, if the master re-reads the same register, it can immediately send another read command, omitting the command to send a register pointer.

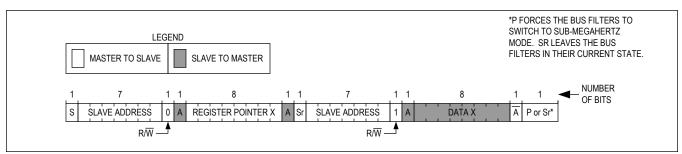


Figure 25. Reading from a Single Register with the Read Byte Protocol

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#### **Reading from Sequential Registers**

<u>Figure 26</u> shows the protocol for reading from sequential registers. This protocol is similar to the read byte protocol except the master issues an acknowledge to signal the slave that it wants more data. When the master has all the data it requires, it issues a not acknowledge (nA) and a stop (P) to end the transmission. The continuous read from sequential registers protocol is as follows:

- 1. The master sends a start command (S).
- 2. The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3. The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4. The master sends an 8-bit register pointer.
- 5. The slave acknowledges the register pointer.
- 6. The master sends a repeated start command (Sr).
- 7. The master sends the 7-bit slave address followed by a read bit (R/W = 1).
- 8. The addressed slave asserts an acknowledge by pulling SDA low.
- 9. The addressed slave places 8-bits of data on the bus from the location specified by the register pointer.
- 10. The master issues an acknowledge (A) signaling the slave that it wishes to receive more data.
- 11. Steps 9 to 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a not acknowledge (nA) to signal that it wishes to stop receiving data.
- 12. The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a stop (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when this device receives a stop, it does not modify its register pointer. Therefore, if the master re-reads the same register, it can immediately send another read command, omitting the command to send a register pointer.

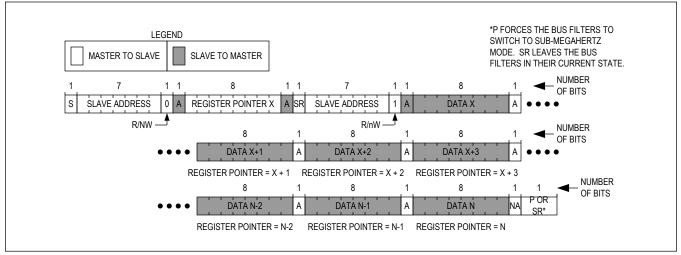


Figure 26. Reading Continuously from Sequential Registers X to N

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### Engaging HS-Mode for Operation up to 3.4MHz

Figure 27 shows the protocol for engaging HS-mode operation. HS-mode operation allows for a bus operating speed up to 3.4MHz. The engaging HS-mode protocol is as follows:

- 1. Begin the protocol while operating at a bus speed of 1MHz or lower.
- 2. The master sends a start command (S).
- 3. The master sends the 8-bit master code of 0b0000 1XXX where 0bXXX are don't care bits.
- 4. The addressed slave issues a not acknowledge (nA).
- 5. The master can increase its bus speed up to 3.4MHz and issue any read/write operation.

The master may continue to issue high-speed read/write operations until a stop (P) is issued. To continue operations in high-speed mode, use repeated start (Sr)

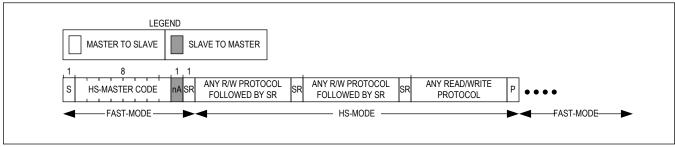


Figure 27. Engaging HS Mode

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## **Register Map**

### MAX77643

ADDRESS	NAME	MSB							LSB
Global									
0x00	INT_GLBL0[7:0]	RSVD	DOD_R	TJAL2_R	TJAL1_R	nEN_R	nEN_F	GPI0_R	GPI0_F
0x01	INT_GLBL1[7:0]	RSVD	RSVD	LDO_F	SBB2_F	SBB1_F	SBB0_F	GPI1_R	GPI1_F
0x02	ERCFLAG[7:0]	WDT_R ST	WDT_O FF	SFT_CR ST_F	SFT_OF F_F	MRST_F	INUVLO	INOVLO	TOVLD
0x03	STAT_GLBL[7:0]	DIDM	BOK	RSVD	DOD_S	TJAL2_S	TJAL1_S	STAT_E N	STAT_IR Q
0x04	INTM_GLBL0[7:0]	RSVD	DOD_R M	TJAL2_R M	TJAL1_R M	nEN_RM	nEN_FM	GPI0_R M	GPI0_F M
0x05	INTM_GLBL1[7:0]	RSVD	RSVD	LDO_M	SBB2_F M	SBB1_F M	SBB0_F M	GPI1_R M	GPI1_F M
0x06	CNFG_GLBL0[7:0]	PU_DIS	MRST	SBIA_LP M	nEN_M	DDE[1:0]	DBEN_n EN	SFT_C1	[RL[1:0]
0x07	CNFG_GLBL1[7:0]			RSVD[4:0]			SBB_F_ SHUTDN	AUTO_V	VKT[1:0]
0x08	CNFG_GPIO0[7:0]	RSVD	-	ALT_GPI O0	DBEN_G PI	DO	DRV	DI	DIR
0x09	CNFG_GPIO1[7:0]	RSVI	D[1:0]	ALT_GPI O1	DBEN_G PI	DO	DRV	DI	DIR
0x10	<u>CID[7:0]</u>	-	-	-			CID[4:0]		
0x17	CNFG_WDT[7:0]	RSVD[1:0] V		WDT_F	ER[1:0] WDT_M ODE		WDT_CL R	WDT_E N	WDT_LO CK
SBB									
0x28	CNFG_SBB_TOP[7:0]	DIS_LP M	-	-	-	-	-	- DRV_SBB[1:0]	
0x29	CNFG_SBB0_A[7:0]				TV_SB	B0[7:0]			
0x2A	CNFG_SBB0_B[7:0]	OP_MC	DE[1:0]	IP_SB	B0[1:0]	ADE_SB B0	E	N_SBB0[2:0	0]
0x2B	CNFG_SBB1_A[7:0]				TV_SB	B1[7:0]			
0x2C	CNFG_SBB1_B[7:0]	OP_MODE[1:0] IP_SBB1[1:0] ADE_SB B1 EN_SBB1			N_SBB1[2:0	0]			
0x2D	CNFG_SBB2_A[7:0]	TV_SBB2[7:0]							
0x2E	CNFG_SBB2_B[7:0]	OP_MODE[1:0] IP_SBB2[1:0] ADE_SB B2			EN_SBB2[2:0]				
0x2F	CNFG_DVS_SBB0_A[7 :0]	TV_SBB0_DVS[7:0]							
LDO									
0x38	CNFG_LDO0_A[7:0]	TV_LDO			-	TV_LDO[6:0	]		
0x39	CNFG_LDO0_B[7:0]	_	_	-	LDO_MD	ADE_LD O	E	EN_LDO[2:0	)]

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### **Register Details**

#### INT\_GLBL0 (0x00)

BIT	7	6	5	4		3	2	1	0
Field	RSVD	DOD_R	TJAL2_R	TJAL1_R	n	EN_R	nEN_F	GPI0_R	GPI0_F
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0
Access Type	Read Clears All	Read Clears All	Read Clears All	Read Clears All		Read ears All	Read Clears All	Read Clears All	Read Clears All
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
RSVD	7	RSVD							
DOD_R	6	LDO Dropou	It Detector Risi	ing Interrupt		0b0 = The LDO has not detected dropout since last time this bit was read. 0b1 = The LDO has detected dropout since the time this bit was read.			
TJAL2_R	5	Thermal Ala	rm 2 Rising Int	errupt	0b0 = The junction temperature has not risen above TJAL2 since the last time this bit was rea 0b1 = The junction temperature has risen above TJAL2 since the last time this bit was read.				
TJAL1_R	4	Thermal Ala	rm 1 Rising Int	I Rising Interrupt I Rising Interrupt 0b0 = The junction temperature has not ri above TJAL1 since the last time this bit w 0b1 = The junction temperature has risen TJAL1 since the last time this bit was read				it was read. sen above	
nEN_R	3	nEN Rising	Interrupt			the last 0b1 = A	o nEN rising ec time this bit wa nEN rising edg this bit was re	s read. ge has occurred	
nEN_F	2	nEN Falling	Interrupt			the last 0b1 = A	o nEN falling e time this bit wa nEN falling ed s bit was read.	s read.	
GPI0_R	1	Note that "G	GPI Rising Interrupt0b0 = No GPI rising edges have occurre last time this bit was read.Note that "GPI" refers to the GPIO programmed to be an input.0b1 = A GPI rising edge has occurred si last time this bit was read.						
GPI0_F	0	GPI Falling Note that the be an input.	·	PIO programme	d to	the last 0b1 = A	o GPI falling ec time this bit wa GPI falling edg this bit was re	s read. ge has occurred	

#### INT\_GLBL1 (0x01)

BIT	7	6	5	4		3	2	1	0
Field	RSVD	RSVD	LDO_F	SBB2_F	SE	3B1_F	SBB0_F	GPI1_R	GPI1_F
Reset	0b000	0b000	0b0	0b0		0b0	0b0	0b0	0b0
Access Type	Read Clears All	Read Clears All	Read Clears All	Read Clears All		Read ears All	Read Clears All	Read Clears All	Read Clears All
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
RSVD	7		Reserved. Unutilized bit. Write to 0. Reads are don't care.						

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BITFIELD	BITS	DESCRIPTION	DECODE
RSVD	6	Reserved. Unutilized bit. Write to 0. Reads are don't care.	
LDO_F	5	LDO Fault Interrupt	0b0 = No fault has occurred on LDO since the last time this bit was read. 0b1 = LDO has fallen out of regulation since the last time this bit was read.
SBB2_F	4	SBB2 Fault Indicator	0b0 = No fault has occurred on SBB2 since the last time this bit was read. 0b1 = SBB2 has fallen out of regulation since the last time this bit was read.
SBB1_F	3	SBB1 Fault Indicator	0b0 = No fault has occurred on SBB1 since the last time this bit was read. 0b1 = SBB1 has fallen out of regulation since the last time this bit was read.
SBB0_F	2	SBB0 Fault Indicator	0b0 = No fault has occurred on SBB0 since the last time this bit was read. 0b1 = SBB0 has fallen out of regulation since the last time this bit was read.
GPI1_R	1	GPI1 Rising Interrupt Note that "GPI" refers to the GPIO programmed to be an input.	0b0 = No GPI1 rising edges have occurred since the last time this bit was read. 0b1 = A GPI1 rising edge has occurred since the last time this bit was read.
GPI1_F	0	GPI1 Falling Interrupt Note that the GPI is the GPIO programmed to be an input.	0b0 = No GPI1 falling edges have occurred since the last time this bit was read. 0b1 = A GPI1 falling edge has occurred since the last time this bit was read.

#### ERCFLAG (0x02)

BIT	7	6	5	4		3	2	1	0	
Field	WDT_RST	WDT_OFF	SFT_CRST _F	SFT_OFF_ F	M	RST_F	INUVLO	INOVLO	TOVLD	
Reset	0b0	0b0	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	Read Clears All	Read Clears All	Read Clears All	Read Clears All	-	Read ears All	Read Clears All	Read Clears All	Read Clears All	
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
WDT_RST	7	when the wa	Watchdog Timer Reset Flag. This bit sets when the watchdog timer expires and causes a power-reset (WDT_MODE = 1).				<ul> <li>0b0 = Watchdog timer has not caused a power reset since the last time this bit was read.</li> <li>0b1 = Watchdog timer has expired and caused a power reset since the last time this bit was read.</li> </ul>			
WDT_OFF	6	when the wa	imer OFF Flag atchdog timer e (WDT_MODE =	xpires and cau	ses	since the 0b1 = W	/atchdog timer e last time this /atchdog timer ff since the last	bit was read. has expired an	d caused a	
SFT_CRST_ F	5	Software Co	old Reset Flag			since the 0b1 = TI the last	he software col e last read of th he software col read of this reg has set SFT_0	his register. d reset has occ ister. This indic	curred since cates that	

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BITFIELD	BITS	DESCRIPTION	DECODE
SFT_OFF_F	4	Software OFF Flag	0b0 = The SFT_OFF function has not occurred since the last read of this register. 0b1 = The SFT_OFF function has occurred since the last read of this register. This indicates that software has set SFT_CTRL[1:0] = 0b10.
MRST_F	3	Manual Reset Timer	0b0 = A manual reset has not occurred since the last read of this register. 0b1 = A manual reset has occurred since the last read of this register.
INUVLO	2	IN Domain Undervoltage Lockout	0b0 = The IN domain undervoltage lockout has not occurred since the last read of this register. 0b1 = The IN domain undervoltage lockout has occurred since the last read of this register. This indicates that the IN domain voltage fell below V <sub>INUVLO</sub> (~2.6V)
INOVLO	1	IN Domain Overvoltage Lockout	0b0 = The IN domain overvoltage lockout has not occurred since the last read of this register. 0b1 = The IN domain overvoltage lockout has occurred since the last read of this register. This indicates that the IN domain voltage rose above VINOVLO (~5.85V)
TOVLD	0	Thermal Overload	0b0 = Thermal overload has not occurred since the last read of this register. 0b1 = Thermal overload has occurred since the last read of this register. This indicates that the junction temperature has exceeded +165°C.

### STAT\_GLBL (0x03)

BIT	7	6	6 5 4			3	2	1	0	
Field	DIDM	BOK	RSVD	DOD_S	ТJ	AL2_S	TJAL1_S	STAT_EN	STAT_IRQ	
Reset	OTP	0b1	0b0	0b0		0b0	0b0	0b0	0b0	
Access Type	Read Only	Read Only	Read Clears All	Read Only Read Only Read Only Read Only				Read Only		
BITFIELD	BITS		DESCRIPT	ION			D	ECODE		
DIDM	7	Device Ident	Device Identification Rits for Metal (Infigure				0b0 = MAX77643 0b1 = Reserved			
вок	6	BOK Interru	BOK Interrupt Status				0b0 = Main bias is not ready. 0b1 = Main bias enabled and ready.			
RSVD	5		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
DOD_S	4	LDO Dropou	ut Detector Risi	ng Status		0b0 = LDO is not in dropout. 0b1 = LDO is in dropout.				
TJAL2_S	3	Thermal Ala	Thermal Alarm 2 Status				ne junction tem ne junction tem			
TJAL1_S	2	Thermal Ala	Thermal Alarm 1 Status				ne junction tem ne junction tem			
STAT_EN	1	Debounced	Status for the r	nEN Input			EN is not active EN is active (lo			

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BITFIELD	BITS	DESCRIPTION	DECODE
STAT IRQ	0	Software Version of the nIRQ MOSFET Gate	0b0 = Unmasked gate drive is logic low.
STAT_IRQ	0	Drive	0b1 = Unmasked gate drive is logic high.

#### INTM GLBL0 (0x04)

BIT	7	6	5	4		3 2 1		0			
Field	RSVD	DOD_RM	TJAL2_RM	TJAL1_RM	nE	N_RM	nEN_FM	GPI0_RM	GPI0_FM		
Reset	0b0	0b1	0b1	0b1		0b1	0b1	0b1	0b1		
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Wri	te, Read	Write, Read	Write, Read	Write, Read		
BITFIELD	BITS		DESCRIPT	ION	D	DECODE					
RSVD	7	Reserved. L are don't car		/rite to 0. Read	S						
DOD_RM	6	LDO Dropou	O Dropout Detector Rising Interrupt Mask O Dropout Detector Rising Interrupt Mask O Dropout Detector Rising Interrupt Mask Ob1 = Masked. nIRQ does not go DOD_R.						all interrupt		
TJAL2_RM	5	Thermal Ala	0b0 = Unmasked. If TJ then nIRQ goes low. n interrupt Mask interrupt bits are cleared						TJAL2_R goes from 0 to 1, nIRQ goes high when all ired. does not go low due to		
TJAL1_RM	4	Thermal Ala	rm 1 Rising Int	errupt Mask		0b0 = Unmasked. If TJAL1_R goes from 0 to 1, then nIRQ goes low. nIRQ goes high when all interrupt bits are cleared. 0b1 = Masked. nIRQ does not go low due to TJAL1_R.					
nEN_RM	3	nEN Rising	Interrupt Mask			nIRQ go bits are	asked. nIRQ d	joes high when	all interrupt		
nEN_FM	2	nEN Falling	Interrupt Mask			nIRQ go bits are	nmasked. If nE bes low. nIRQ g cleared. asked. nIRQ d	joes high when	all interrupt		
GPI0_RM	1	GPI0 Rising						PI0_R goes from goes high when oes not go low	all interrupt		
GPI0_FM	0	GPI0 Falling	Interrupt Mas	k		nIRQ go bits are	asked. nIRQ d	joes high when	all interrupt		

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#### INTM\_GLBL1 (0x05)

BIT	7	6	5	4	3 2 1		0			
Field	RSVD	RSVD	LDO_M	SBB2_FM	SB	B1_FM	SBB0_FM	GPI1_RM	GPI1_FM	
Reset	0b0	0b0	0b1	0b0		0b0	0b0	0b1	0b1	
Access Type	Write, Read	Write, Read	Write, Read	Write, Read	Wri	te, Read	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
RSVD	7	Reserved. U are don't car		/rite to 0. Read	S					
RSVD	6	Reserved. U are don't car		/rite to 0. Read	S					
LDO_M	5	LDO Fault Ir	DO Fault Interrupt Mask				0b0 = Unmasked. If LDO_F goes from 0 to 1, the nIRQ goes low. nIRQ goes high when all interru bits are cleared. 0b1 = Masked. nIRQ does not go low due to LDO_F.			
SBB2_FM	4	SBB2 Fault	SBB2 Fault Interrupt Mask				0b0 = Unmasked. If SBB2_F goes from 0 to 1, then nIRQ goes low. nIRQ goes high when all interrupt bits are cleared. 0b1 = Masked. nIRQ does not go low due to SBB2_F.			
SBB1_FM	3	SBB1 Fault	Interrupt Mask			nIRQ go bits are	asked. nIRQ d	loes high when	all interrupt	
SBB0_FM	2	SBB0 Fault	SBB0 Fault Interrupt Mask			0b0 = Unmasked. If SBB0_F goes from 0 to 1, then nIRQ goes low. nIRQ goes high when all interrupt bits are cleared. 0b1 = Masked. nIRQ does not go low due to SBB0_F.			when all	
GPI1_RM	1	GPI1 Rising	GPI1 Rising Interrupt Mask			0b0 = Unmasked. If GPI1_R goes from 0 to         nIRQ goes low. nIRQ goes high when all int         bits are cleared.         0b1 = Masked. nIRQ does not go low due to         GPI1_R.			all interrupt	
GPI1_FM	0	GPI1 Falling	Interrupt Masl	ĸ		nIRQ go bits are	asked. nIRQ d	loes high when	all interrupt	

#### CNFG\_GLBL0 (0x06)

BIT	7	6	5	4	3	2	1	0
Field	PU_DIS	MRST	SBIA_LPM	nEN_MODE[1:0]		DBEN_nEN	SFT_C1	RL[1:0]
Reset	0b0	OTP	OTP	OTP		OTP	0b00	
Access Type	Write, Read	Write, Read	Write, Read	Write,	Write, Read		Write,	Read

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
PU_DIS	7	nEN Internal Pullup Resistor	0b0 = Strong internal nEN pullup (200kΩ) 0b1 = Weak internal nEN pullup (10MΩ)
MRST	6	Sets the Manual Reset Time (t <sub>MRST</sub> )	0b0 = 8s 0b1 = 4s
SBIA_LPM	5	Main Bias Power Mode	0b0 = Main bias is in normal-power mode by software. 0b1 = Main bias is in auto power mode by software.
nEN_MODE	4:3	nEN Input (ON-KEY) Default Configuration Mode	0b00 = Push-button mode 0b01 = Slide-switch mode 0b10 = Logic mode 0b11 = Reserved
DBEN_nEN	2	Debounce Timer Enable for the nEN Pin	0b0 = 500µs Debounce 0b1 = 30ms Debounce Applies only to push button and slide switch Mmode
SFT_CTRL	1:0	Software Reset Functions Note that the SFT_CRST and SFT_OFF commands initiate the power-down sequence flow as described in the data sheet. This power-down sequence flow has delay elements that add up to 205.24ms (60ms delay + 10.24ms nRST assert delay + 4x2.56ms power-down slot delays + 125ms output discharge delay). If issuing the SFT_CRST and/or SFT_OFF functions in software, wait for more than 300ms before trying to issue any additional commands through I <sup>2</sup> C.	0b00 = No action 0b01 = Software cold reset (SFT_CRST). The device powers down, resets, and then powers up again. 0b10 = Software off (SFT_OFF). The device powers down, resets, and then remains off and waiting for a wake-up event. 0b11 = Auto Wake Up (SFT_AUTO) The device powers down, and then automatically starts power up sequence after time determined in AUTO_WKT. Note that the registers do not get reset with Auto Wake Up.

#### CNFG\_GLBL1 (0x07)

BIT	7	6	5	4		3	2	1	0	
Field			RSVD[4:0]			SBB_F_SH UTDN AUTO_WKT[1				
Reset			0b0000				OTP	0x	00	
Access Type			Write, Read				Write, Read	Write,	Read	
BITFIELD	BITS		DESCRIPT	ION			DECODE			
RSVD	7:3	Reserved. L are don't ca	Inutilized bit. W re.	/rite to 0. Read	S					
SBB_F_SHU TDN	2	SBB Shutdo	wn from SBB F	Fault	0b0 = The SBB regulators do not shut off whe SBB fault occurs. 0b1 = The SBB regulators powers down sequentially when a SBB fault occurs.				wn	
AUTO_WKT	1:0	Auto Wake-	Auto Wake-Up Timer				100ms Auto Wa 200ms Auto Wa 500ms Auto Wa 1000ms Auto W	ake-up Time ake-up Time		

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#### CNFG\_GPIO0 (0x08)

BIT	7	6	5	4		3 2 1 0				
Field	RSVD	_	ALT_GPIO0	DBEN_GPI		DO	DRV	DI	DIR	
Reset	0b0	_	OTP	0b0		0b0	0b0	0b0	0b1	
Access Type	Write, Read	-	Write, Read	Write, Read	Wri	Write, Read Write, Read Read Only Write				
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE		
RSVD	7		Reserved. Unutilized bit. Write to 0. Reads are don't care.							
ALT_GPIO0	5	Alternate Mo	Iternate Mode Enable for GPIO0				BB0 is set by T BB0 is set by T			
DBEN_GPI	4	General Pur Enable	General Purpose Input Debounce Timer Enable			0b0 = No debounce 0b1 = 30ms debounce				
DO	3	General Pur	General Purpose Output Data Output				is a don't care v et for GPO (DIF PIO is output lo PIO is output lo out (DRV = 1). ( et as an open-d	R = 0): ogic low. ogic high when GPIO is high-ir	set as push- npedance	
DRV	2	General Pur	pose Output D	river Type		input). When se	is a don't care v et for GPO (DIF pen-drain ush-pull		configured as	
DI	1	whether the	GPIO Digital Input Value. Irrespective of whether the GPIO is set for GPI (DIR = 1) or GPO (DIR = 0), DI reflects the state of the GPIO.				put logic low put logic high			
DIR	0	GPIO Direct	ion				eneral purpose eneral purpose			

#### CNFG\_GPIO1 (0x09)

BIT	7	6	5	4		3	2	1	0	
Field	RSVE	0[1:0]	1:0] ALT_GPIO1 DBEN_GPI I			DO	DRV	DI	DIR	
Reset	060	00	OTP	0b0		0b0	0b0	0b0	0b1	
Access Type	Write,	Read	ead Write, Read Write, Read Write				Write, Read	Read Only	Write, Read	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
RSVD	7:6	Reserved. L are don't ca	Inutilized bit. W re.	rite to 0. Read	S					
ALT_GPIO1	5	Alternate Mo	Alternate Mode Enable for GPIO1				tandard GPIO. exible power s 2.	equencer activ	e-high output	
DBEN_GPI	4	General Pur Enable	pose Input Det	oounce Timer			o debounce Oms debounce			

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
DO	3	General Purpose Output Data Output	This bit is a don't care when DIR = 1 (configured as input). When set for GPO (DIR = 0): 0b0 = GPIO is output logic low. 0b1 = GPIO is output logic high when set as push- pull output (DRV = 1). GPIO is high-impedance when set as an open-drain output (DRV = 0).
DRV	2	General Purpose Output Driver Type	This bit is a don't care when DIR = 1 (configured as input). When set for GPO (DIR = 0): 0b0 = Open-drain 0b1 = Push-pull
DI	1	GPIO Digital Input Value. Irrespective of whether the GPIO is set for GPI (DIR = 1) or GPO (DIR = 0), DI reflects the state of the GPIO.	0b0 = Input logic low 0b1 = Input logic high
DIR	0	GPIO Direction	0b0 = General purpose output (GPO) 0b1 = General purpose input (GPI)

#### CID (0x10)

BIT	7	6	5		4 3 2 1 0												
Field	_	-	-		CID[4:0]												
Reset	_	-	_		OTP							OTP					
Access Type	-	_	-		Read Only						Read Only						
BITFIE	LD	BITS			DESCRIPTION												
CID		4:0		The c	<ul> <li>Identification Code</li> <li>chip identification code refers to a set of reset values in the register map,</li> <li>"OTP configuration."</li> </ul>												

#### CNFG\_WDT (0x17)

BIT	7	6	6 5 4			3	2	1	0
Field	RSVI	D[1:0]	WDT_PER[1:0] W			T_MOD E	WDT_CLR	WDT_EN	WDT_LOC K
Reset	0b	00	0b	011		0b0	0b0	OTP	OTP
Access Type	Write,	Read	Write, Read Write			te, Read	Write, Read	Write, Read	Read Only
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE	
RSVD	7:6	Reserved. U are don't car		/rite to 0. Read	S				
WDT_PER	5:4	timer is rese	Vatchdog Timer Period. Sets t <sub>WD</sub> . Watchdog mer is reset to the programmed value as oon as this bitfield is changed.				16 seconds 32 seconds 54 seconds 128 seconds		

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
WDT_MODE	3	Watchdog Timer Expired Action. Determines what the IC does after the watchdog timer expires.	0b0 = Watchdog timer expire causes power-off. 0b1 = Watchdog timer expire causes power reset.
WDT_CLR	2	Watchdog Timer Clear Control. Set this bit to feed (reset) the watchdog timer.	0b0 = Watchdog timer period is not reset. 0b1 = Watchdog timer is reset back to t <sub>WD</sub> .
WDT_EN	1	Watchdog Timer Enable. Write protected depending on WDT_LOCK.	0b0 = Watchdog timer is not enabled. 0b1 = Watchdog timer is enabled. The timer expires if not reset by setting WDT_CLR.
WDT_LOCK	0	Factory-Set Safety Bit for the Watchdog Timer. Determines if the timer can be disabled through WDT_EN or not.	0b0 = Watchdog timer can be enabled and disabled with WDT_EN. 0b1 = Watchdog timer can not be disabled with WDT_EN. However, WDT_EN can still be used to enable the watchdog timer.

### CNFG\_SBB\_TOP (0x28)

BIT	7	6	5	4		3 2 1 0			0
Field	DIS_LPM	_	_	_		– – DRV.			BB[1:0]
Reset	0b0	-	-	-		– – OTP			ГР
Access Type	Write, Read	-	-	-		– – Write, Read			
BITFIELD	BITS		DESCRIPTION DECODE						
DIS_LPM	7	Disables the Each SIMO	e Automatic Lov Channel.	v-Power Mode	for	channel	isable low pow		
DRV_SBB	1:0	Strength Tri	SIMO Buck-Boost (All Channels) Drive Strength Trim.0b00 = Fastest transition time 0b01 = A little slower than 0b00 0b10 = A little slower than 0b01 0b11 = A little slower than 0b10See the Drive Strength section for more details.0b10 = A little slower than 0b01 0b11 = A little slower than 0b10						

#### CNFG\_SBB0\_A (0x29)

BIT	7	6	5	4	3	2	1	0		
Field		TV_SBB0[7:0]								
Reset		OTP								
Access Type				Write,	Read					

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BITFIELD	BITS	DESCRIPTION	DECODE
TV_SBB0	7:0	SIMO Buck-Boost Channel 0 Target Output Voltage This 8-bit configuration is a linear transfer function that starts at 0.5V and ends at 5.5V with 25mV increments.	$\begin{array}{l} 0x00 = 0.500V\\ 0x01 = 0.525V\\ 0x02 = 0.550V\\ 0x03 = 0.575V\\ 0x04 = 0.600V\\ 0x05 = 0.625V\\ 0x06 = 0.650V\\ 0x07 = 0.675V\\ 0x08 = 0.700V\\ \dots\\ 0xC5 = 5.425V\\ 0xC6 = 5.450V\\ 0xC7 = 5.475V\\ 0xC8 \text{ to } 0xFF = 5.500V \end{array}$

#### CNFG\_SBB0\_B (0x2A)

BIT	7	6	5	4 3 2 1					0
Field	OP_MOI	DE[1:0]	IP_SB	B0[1:0]	ADI	E_SBB0		EN_SBB0[2:0]	
Reset	OT	Р	0.	TP		OTP		OTP	
Access Type	Write,	Read	Write,	Read	Wri	te, Read		Write, Read	
BITFIELD	BITS		DESCRIPT	ION	DECODE				
OP_MODE	7:6	Operation M	tion Mode of SBB0 0b00 = Automatic 0b01 = Buck mode 0b10 = Boost mode 0b11 = Buck-boost mode						
IP_SBB0	5:4	SIMO Buck- Limit	uck-Boost Channel 0 Peak Current				1.000A 0.750A 0.500A 0.333A		
ADE_SBB0	3	SIMO Buck- Discharge E	Boost Channel nable	0 Active-	0b0 = The active discharge function is disab         When SBB0 is disabled, its discharge rate is         function of the output capacitance and the ex         load.         0b1 = The active discharge function is enabled         When SBB0 is disabled, an internal resistor         (R <sub>AD_SBB0</sub> ) is activated from SBB0 to PGNI         help the output voltage discharge. The output         voltage discharge rate is a function of the output         capacitance, the external loading, and the in         R <sub>AD_SBB0</sub> load.				
EN_SBB0	2:0	0. Select the powers up a the channel Prior to enal circuits to no 0). After the circuits may	FIND FOR SIMO B FPS slot that nd powers dow is forced on or pling the SIMO prmal-power mo SIMO is enable be programme (SBIA_LPM = urrent.	the channel vn in or whethe off. , program the t ode (SBIA_LPI ed, the bias ed back to low-	er bias VI =	0b001 = 0b010 = 0b011 = 0b100 = 0b101 = 0b101 =	FPS slot 0 FPS slot 1 FPS slot 2 FPS slot 3 Off irrespectiv Same as 0b1 On irrespectiv Same as 0b1	00 ve of FPS	

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#### CNFG\_SBB1\_A (0x2B)

BIT	7	6	5	4	3	2	1	0						
Field		•	TV_SBB1[7:0]											
Reset				0	TP									
Access Type		Write, Read												
BITFIELD	BITS		DESCRIPTION DECODE											
TV_SBB1	7:0	Voltage This 8-bit co	onfiguration is a t starts at 0.5V	I 1 Target Outp a linear transfer and ends at 5.	$ \begin{array}{c} 0x05 = 0\\ 0x06 = 0\\ 0x07 = 0\\ 0x08 = 0\\ \dots\\ 0xC5 = 0\\ 0xC6 = 0\\ 0xC7 $	0.525V 0.550V 0.575V 0.600V 0.625V 0.650V 0.650V 0.675V 0.700V 5.425V 5.425V 5.450V	W							

#### CNFG\_SBB1\_B (0x2C)

BIT	7	6	5	4         3         2         1           SBB1[1:0]         ADE_SBB1         EN_SBB1[2:0]					0	
Field	OP_MO	DE[1:0]	IP_SB	B1[1:0]	AD	E_SBB1	B1 EN_SBB1[2:0]			
Reset	ОТ	P	0	TP		OTP		OTP		
Access Type	Write,	Read	Write, Read Write, Read Write, Read							
BITFIELD	BITS		DESCRIPTION DECODE							
OP_MODE	7:6	Operation M	ode of SBB1	0b00 = Automatic 0b01 = Buck mode						
IP_SBB1	5:4	SIMO Buck- Limit	Buck-Boost Channel 1 Peak Current 0b00 = 1.000A 0b01 = 0.750A 0b10 = 0.500A 0b11 = 0.333A							
ADE_SBB1	3	SIMO Buck- Discharge E	Boost Channe nable	1 Active-		When S function load. 0b1 = TH When S (R <sub>AD_SF</sub> help the voltage of	BB1 is disable of the output of ne active disch BB1 is disable BB1 is activate output voltage discharge rate nce, the extern	arge function is d, its discharge capacitance and arge function is d, an internal re ed from SBB1 to e discharge. The is a function of nal loading, and	rate is a the external enabled. sistor PGND to output the output	

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
EN_SBB1	2:0	Enable Control for SIMO Buck-Boost Channel 1. Select the FPS slot that the channel powers up and powers down in or whether the channel is forced on or off. Prior to enabling the SIMO, program the bias circuits to normal-power mode (SBIA_LPM = 0). After the SIMO is enabled, the bias circuits may be programmed back to low- power mode (SBIA_LPM = 1) to decrease quiescent current.	$\begin{array}{l} 0b000 = FPS \ slot \ 0 \\ 0b001 = FPS \ slot \ 1 \\ 0b010 = FPS \ slot \ 2 \\ 0b011 = FPS \ slot \ 3 \\ 0b100 = Off \ irrespective \ of \ FPS \\ 0b101 = Same \ as \ 0b100 \\ 0b110 = On \ irrespective \ of \ FPS \\ 0b111 = Same \ as \ 0b110 \end{array}$

#### CNFG\_SBB2\_A (0x2D)

BIT	7	6	5	4	3	2	1	0		
Field	TV_SBB2[7:0]									
Reset	OTP									
Access Type	Write, Read									
BITFIELD	BITS		DESCRIPTI	ON		D	ECODE			
TV_SBB2	7:0	Voltage This 8-bit co	Boost Channel onfiguration is a t starts at 0.5V a ncrements.	linear transfer	0x01 = 0 0x02 = 0 0x03 = 0 0x04 = 0 0x05 = 0 0x06 = 0 0x07 = 0 0x08 = 0  0xC5 = 0xC6 =	$\begin{array}{c} 0x00 = 0.500V\\ 0x01 = 0.525V\\ 0x02 = 0.550V\\ 0x03 = 0.575V\\ 0x04 = 0.600V\\ 0x05 = 0.625V\\ 0x06 = 0.650V\\ 0x07 = 0.675V\\ 0x08 = 0.700V \end{array}$				

#### CNFG\_SBB2\_B (0x2E)

BIT	7	6	5	4		3	2	1	0	
Field	OP_MO	DE[1:0]	IP_SB	B2[1:0]	AD	E_SBB2		EN_SBB2[2:0]		
Reset	ОТ	P	0.	TP		OTP		OTP		
Access Type	Write, Read		Write, Read		Writ	ite, Read Write, Read				
BITFIELD	BITS		DESCRIPTION				DECODE			
OP_MODE	7:6	Operation M	Operation Mode of SBB2				0b00 = Automatic 0b01 = Buck mode 0b10 = Boost mode 0b11 = Buck-boost mode			
IP_SBB2	5:4	SIMO Buck- Limit	uck-Boost Channel 2 Peak Current			0b00 = 1.000A 0b01 = 0.750A 0b10 = 0.500A 0b11 = 0.333A				

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
ADE_SBB2	3	SIMO Buck-Boost Channel 2 Active- Discharge Enable	$\begin{array}{l} 0b0 = \mbox{The active discharge function is disabled.} \\ When SBB2 is disabled, its discharge rate is a function of the output capacitance and the external load. \\ 0b1 = \mbox{The active discharge function is enabled.} \\ When SBB2 is disabled, an internal resistor (R_{AD\_SB2}) is activated from SBB2 to PGND to help the output voltage discharge. The output voltage discharge rate is a function of the output capacitance, the external loading, and the internal R_{AD\_SB2} load. \\ \end{array}$
EN_SBB2	2:0	Enable Control for SIMO Buck-Boost Channel 2. Select the FPS slot that the channel powers up and powers down in or whether the channel is forced on or off. Prior to enabling the SIMO, program the bias circuits to normal power mode (SBIA_LPM = 0). After the SIMO is enabled, the bias circuits may be programmed back to low power mode (SBIA_LPM = 1) to decrease quiescent current.	0b000 = FPS  slot  0 0b001 = FPS  slot  1 0b010 = FPS  slot  2 0b011 = FPS  slot  3 0b100 = Off  irrespective of FPS 0b101 =  Same as  0b100 0b110 =  On irrespective of FPS 0b111 =  Same as  0b110

#### CNFG\_DVS\_SBB0\_A (0x2F)

BIT	7	6	5	4	3	2	1	0		
Field	TV_SBB0_DVS[7:0]									
Reset		0x14								
Access Type		Write, Read								
BITFIELD	BITS	BITS DESCRIPTION DECODE								
TV_SBB0_D VS	7:0	Voltage This 7-bit co	onfiguration is a t starts at 0.5V	el 0 Target Outp a linear transfer and ends at 5.	0x05 = 0x06 = 0x07 = 0x08 =  0xC5 = 0xC6 = 0xC7 =	0.525V 0.550V 0.575V 0.600V 0.625V 0.650V 0.675V 0.700V 5.425V 5.450V	V			

#### CNFG\_LDO0\_A (0x38)

BIT	7	6	5	4	3	2	1	0
Field	TV_LDO		TV_LDO[6:0]					
Reset	0xOTP		OTP					
Access Type	Write, Read		Write, Read					

# Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

BITFIELD	BITS	DESCRIPTION	DECODE
TV_LDO	7	LDO Output Voltage. This bit applies a 1.325V offset to the output voltage of the LDO.	0b0 = No Offset 0b1 = 1.325V Offset
TV_LDO	6:0	LDO Target Output Voltage This 7-bit configuration is a linear transfer function that starts at 0.5V and ends at 3.675V with 25mV increments.	0x00 = 0.500V 0x01 = 0.525V 0x02 = 0.550V 0x03 = 0.575V 0x04 = 0.600V 0x05 = 0.625V 0x06 = 0.650V 0x07 = 0.675V 0x08 = 0.700V  0x7E = 3.650V 0x7F = 3.675V When TV_LDO[7] = 0, TV_LDO[6:0] sets the LDO's output voltage range from 0.5V to 3.675V. When TV_LDO[7] = 1, TV_LDO[6:0] sets the LDO's output voltage from 1.825V to 5V.

#### <u>CNFG\_LDO0\_B (0x39)</u>

BIT	7	6	5	4		3	2	1	0
Field	_	_	_	LDO_MD	AD	E_LDO	EN_LDO[2:0]		
Reset	_	_	_	OTP		OTP		OTP	
Access Type	-	-	-	Write, Read	Writ	e, Read		Write, Read	
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
LDO_MD	4	Operation M	lode of LDO			0b0 = Low dropout linear regulator (LDO) mode 0b1 = Load switch (LSW) mode			DO) mode
ADE_LDO	3	LDO Active-	LDO Active-Discharge Enable			When Ll function load. 0b1 = TI When Ll $(R_{AD}_{LL})$ the outp discharge	DO0 is disable of the output of he active disch DO is disabled DO) is activated ut voltage disc ge rate is a fundance, the extern	arge function is d, its discharge capacitance and arge function is , an internal res from LDO to G harge. The out ction of the out nal loading, and	rate is a I the external e enabled. sistor GND to help but voltage but
EN_LDO	2:0	that the cha	Enable Control for LDO. Select the FPS slot that the channel powers up and powers down in or whether the channel is forced on or off.			0b001 = 0b010 = 0b011 = 0b100 = 0b101 = 0b110 =	FPS slot 0 FPS slot 1 FPS slot 2 FPS slot 3 Off irrespectiv Same as 0b10 On irrespectiv Same as 0b1	00 re of FPS	

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### **Typical Application Circuits**

### **Typical Applications Circuit**

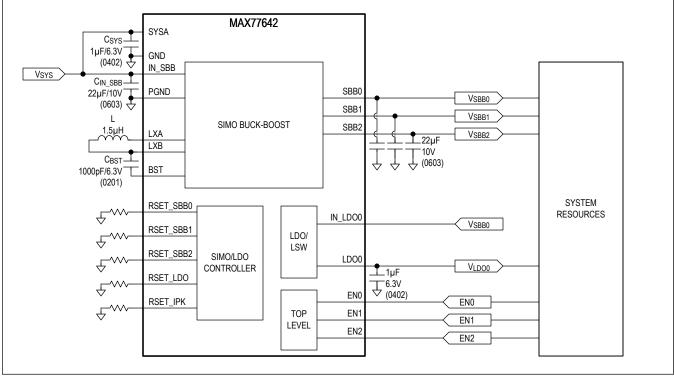


Figure 28. Typical Applications Circuit - R<sub>SEL</sub> Version (MAX77642)

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#### MAX77643 SYSA C<sub>SYS</sub>\_\_ 1µF/6.3V GND (0402) IN\_SBB Vsys Csys PGND SBB0 22µF/10V ÷ V<sub>SBB0</sub> (0603) SBB1 VSBB1 1 SIMO BUCK-BOOST SBB2 1.5µH LXA VSBB2 . 22µF SYSTEM LXB RESOURCES 10V CBST T ↓ (0603) BST 1000pF/6.3V Т GPI00 (0201) IN\_LDO V<sub>SBB0</sub> LDO LDO VLD00 \_\_\_\_\_1µF GPI00 Vio GPI00 VIO/POWER GPI01 GPI01 Ŷ SDA SDA TOP LEVEL/I<sup>2</sup>C/GPIO SCL PROCESSOR SCL nEN ⊈° nRST nRST nIRQ nIRQ \*PULLUP RESISTORS NOT DRAWN

### **Typical Application Circuits (continued)**

Figure 29. Typical Applications Circuit - I<sup>2</sup>C Version (MAX77643)

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE	OPTIONS
MAX77642ANA+T	-40°C to +125°C	25 WLP	—
MAX77643ANA+T*	-40°C to +125°C	25 WLP	—
<b>MAX77643A</b> ANA+T	-40°C to +125°C	25 WLP	Table 3

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

\*Custom samples only. Not for production or stock. Contact factory for more information.

### Ultra Configurable PMIC Featuring 93% Peak Efficiency Single-Inductor, 3-Output Buck-Boost, 1-LDO for Long Battery Life Applications

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/20	Initial release	—
1	10/20	Updated the Ordering Information table	88

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